

- Tentative Specification
 Preliminary Specification
 Approval Specification

MODEL NO.: V580DK1

SUFFIX: KS1

Rev.

Customer:	
APPROVED BY	SIGNATURE
Name / Title _____	
Note _____	
Please return 1 copy for your confirmation with your signature and comments.	

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REVISION HISTORY

Version	Date	Page (New)	Section	Description
Ver. 1.0	12/25, 2012	All	All	The preliminary specification was firstly issued.
Ver. 1.1	02/25, 2013	12-14	3.2	Converter Characteristics
		17	5.2	Backlight unit pin define
			5.3	Converter unit pin define

1. GENERAL DESCRIPTION

1.1 OVERVIEW

USMP-V580DK1-KS1 is a 58" TFT Liquid Crystal Display module with LED Backlight unit and 16 Lane V-by-one interface. This module supports 3840 x 2160 Quad Full HDTV format and can display true 1.07G colors (8-bit+FRC). The driving board module for backlight is built-in.

1.2 FEATURES

- High brightness (400 nits)
- High contrast ratio (5000:1)
- Fast response time (Gray to Gray typical : 6.5 ms)
- High color saturation (NTSC 72%)
- Quad Full HDTV (3840 x 2160 pixels) resolution, true HDTV format
- V-by-One interface
- Optimized response time for 120Hz frame rate
- Viewing Angle : 178(H)/178(V) (CR>20) VA Technology
- Ultra wide viewing angle: Super MVA technology
- RoHs compliance
- T-con input frame rate : FHD 100/120Hz or QFHD 24/30Hz,
Output frame rate: QFHD 100/120Hz or QFHD 48Hz/60Hz

1.3 APPLICATION

- Standard Living Room TVs
- Public Display Application
- Home Theater Application
- MFM Application

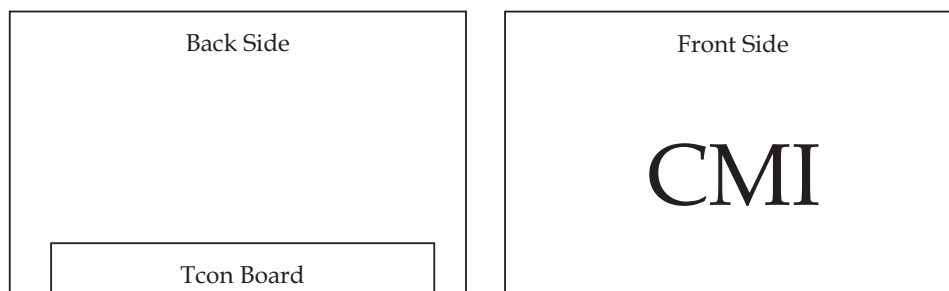
1.4 GENERAL SPECIFICATIONS

Item	Specification	Unit	Note
Active Area	1270.08 (H) x 721.44 (V) (58" diagonal)	mm	(1)
Bezel Opening Area	1275.3 (H) x 726.7 (V)	mm	
Driver Element	a-si TFT active matrix	-	-
Pixel Number	3840 x R.G.B. x 2160	pixel	-
Pixel Pitch(Sub Pixel)	0.334(H) x 0.334 (V)	mm	-
Pixel Arrangement	RGB vertical stripe	-	-
Display Colors	1.07G colors (8-bit+FRC)	color	-
Display Operation Mode	Transmissive mode / Normally black	-	-
Surface Treatment	Anti-Glare coating (Haze 1%) Hardness 3H	-	(2)
Rotation Function	Unachievable		(3)
Display Orientation	Signal input with "CMI"		(3)

Note (1) Please refer to the attached drawings in chapter 11 for more information about the front and back outlines.

Note (2) The spec of the surface treatment is temporarily for this phase. CMI reserves the rights to change this feature.

Note (3)



1.5 MECHANICAL SPECIFICATIONS

Item		Min.	Typ.	Max.	Unit	Note
Module Size	Horizontal (H)	1288.8	1290.3	1291.8	mm	(1),(2)
	Vertical (V)	743.5	744.7	745.9	mm	(1),(2)
	Depth (D)	15.2	16.2	17.2	mm	To Rear
		26.6	27.6	28.6	mm	To converter cover
Weight			19230		g	

Note (1) Please refer to the attached drawings for more information of front and back outline dimensions.

Note (2) Module Depth does not include connectors.

2. ABSOLUTE MAXIMUM RATINGS
2.1 ABSOLUTE RATINGS OF ENVIRONMENT

Item	Symbol	Value		Unit	Note
		Min.	Max.		
Storage Temperature	T _{ST}	-20	+60	°C	(1)
Operating Ambient Temperature	T _{OP}	0	50	°C	(1), (2)
Shock (Non-Operating)	S _{NOP}	-	35	G	(3), (5)
Vibration (Non-Operating)	V _{NOP}	-	1.0	G	(4), (5)

Note (1) Temperature and relative humidity range is shown in the figure below.

(a) 90 %RH Max. ($T_a \leq 40$ °C).

(b) Wet-bulb temperature should be 39 °C Max. ($T_a > 40$ °C).

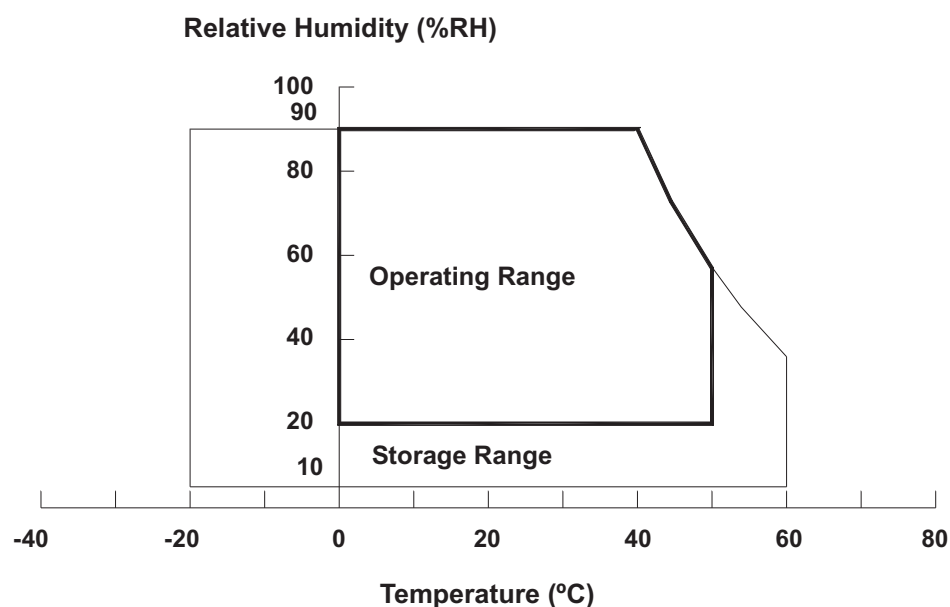
(c) No condensation.

Note (2) Thermal management should be considered in final product design to prevent the surface temperature of display area from being over 65 °C. The range of operating temperature may degrade in case of improper thermal management in final product design.

Note (3) 11 ms, half sine wave, 1 time for $\pm X$, $\pm Y$, $\pm Z$.

Note (4) 10 ~ 200 Hz, 30 min, 1 time each X, Y, Z.

Note (5) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.



2.2 PACKAGE STORAGE

When storing modules as spares for a long time, the following precaution is necessary.

- (a) Do not leave the module in high temperature, and high humidity for a long time, It is highly recommended to store the module with temperature from 0 to 35 °C at normal humidity without condensation.
- (b) The module shall be stored in dark place. Do not store the TFT-LCD module in direct sunlight or fluorescent light.

2.3 ELECTRICAL ABSOLUTE RATINGS

2.3.1 TFT LCD MODULE

Item	Symbol	Value		Unit	Note
		Min.	Max.		
Power Supply Voltage	V _{CC}	-0.3	13.5	V	(1)
Logic Input Voltage	V _{IN}	-0.3	3.6	V	

2.3.2 BACKLIGHT CONVERTER UNIT

Item	Symbol	Test Condition	Min.	Type	Max.	Unit	Note
Light Bar Voltage	V _W	Ta = 25 °C	-	-	70	V _{RMS}	3D Mode
Converter Input Voltage	V _{BL}	-	-0.3	-	30	V	
Control Signal Level	-	-	-0.3	-	6	V	

Note (1) Permanent damage to the device may occur if maximum values are exceeded. Function operation should be restricted to the conditions described under Normal Operating Conditions.

Note (2) No moisture condensation or freezing.

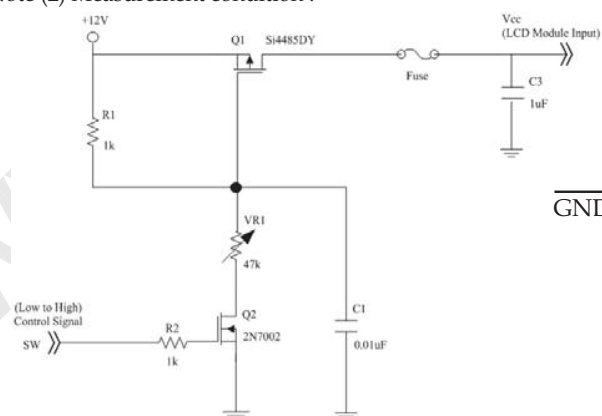
Note (3) The control signals include On/Off Control and External PWM Control.

3. ELECTRICAL CHARACTERISTICS
3.1 TFT LCD MODULE
 $(T_a = 25 \pm 2 \text{ }^\circ\text{C})$

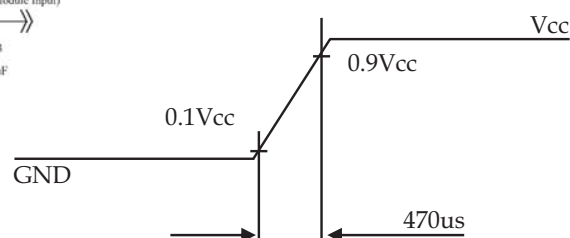
Parameter	Symbol	Value			Unit	Note	
		Min.	Typ.	Max.			
Power Supply Voltage	VCC	10.8	12	13.2	V	(1)	
Rush Current	IRUSH	—	—	7	A	(2)	
Power Consumption	White Pattern	—	16.1	21	W	(3)	
	Black Pattern	—	16.2	21			
	Horizontal Pattern	—	34.2	51			
Power Supply Current	White Pattern	—	1.37	1.7	A	(3)	
	Black Pattern	—	1.35	1.7			
	Horizontal Pattern	—	2.85	4.2			
LVDS interface	Differential Input High Threshold Voltage	V_{LVTH}	+100	—	+300	mV	(4)
	Differential Input Low Threshold Voltage	V_{LVTL}	-300	—	-100	mV	
	Common Input Voltage	V_{CM}	1.0	1.2	1.4	V	
	Differential input voltage (single-end)	$ V_{ID} $	200	—	600	mV	
CMOS interface	Input High Threshold Voltage	V_{IH}	2.7	—	3.3	V	
	Input Low Threshold Voltage	V_{IL}	0	—	0.7	V	

Note (1) The module should be always operated within the above ranges. The ripple voltage should be controlled under 10% of Vcc (Typ.)

Note (2) Measurement condition :



Vcc rising time is 470us



Note (3) The specified power supply current is under the conditions at $V_{CC} = 12\text{ V}$, $T_a = 25 \pm 2\text{ }^\circ\text{C}$, $f_v = 120\text{ Hz}$, whereas a power dissipation check pattern below is displayed.

a. White Pattern



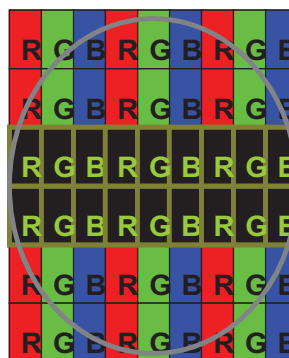
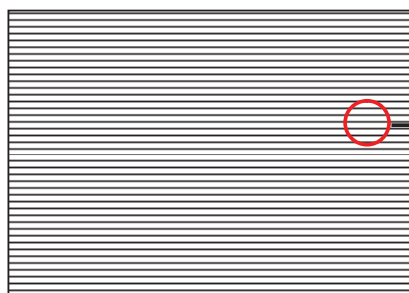
Active Area

b. Black Pattern

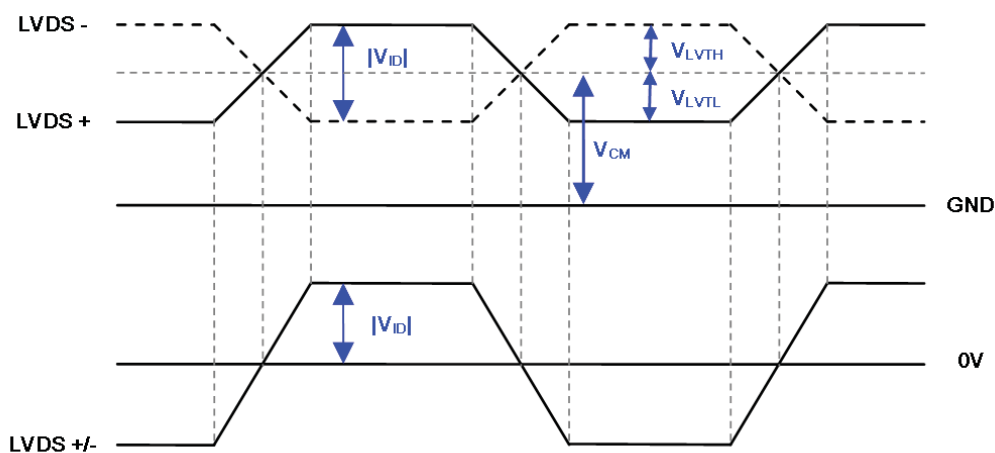


Active Area

c. Heavy Loading pattern



Note (4) The LVDS input characteristics is shown as below :



3.2 BACKLIGHT UNIT

3.2.1 CONVERTER CHARACTERISTICS

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
Power Consumption	$P_{BL(2D)}$	—	129	142	W	(1), (2)
	$P_{BL(3D)}$	—	129	142	W	(1), (2)
Converter Input Voltage	VBL	22.8	24.0	26.4	VDC	
Converter Input Current	$I_{BL(2D)}$	—	5.4	6.2	A	Non Dimming
	$I_{BL(3D)}$	—	5.4	6.2	A	
Input Inrush Current	$I_{R(2D)}$	—	—	12	Apeak	$V_{BL}=22.8V$, ($I_L=typ.$) (3), (5)
	$I_{R(3D)}$	—	—	15	Apeak	$V_{BL}=22.8V$ (3), (5)
Dimming Frequency	FB	170	180	190	Hz	(4)
Dimming Duty Ratio	DDR	0	-	100	%	(4)
Life Time	-	30,000	-	-	Hrs	(6)

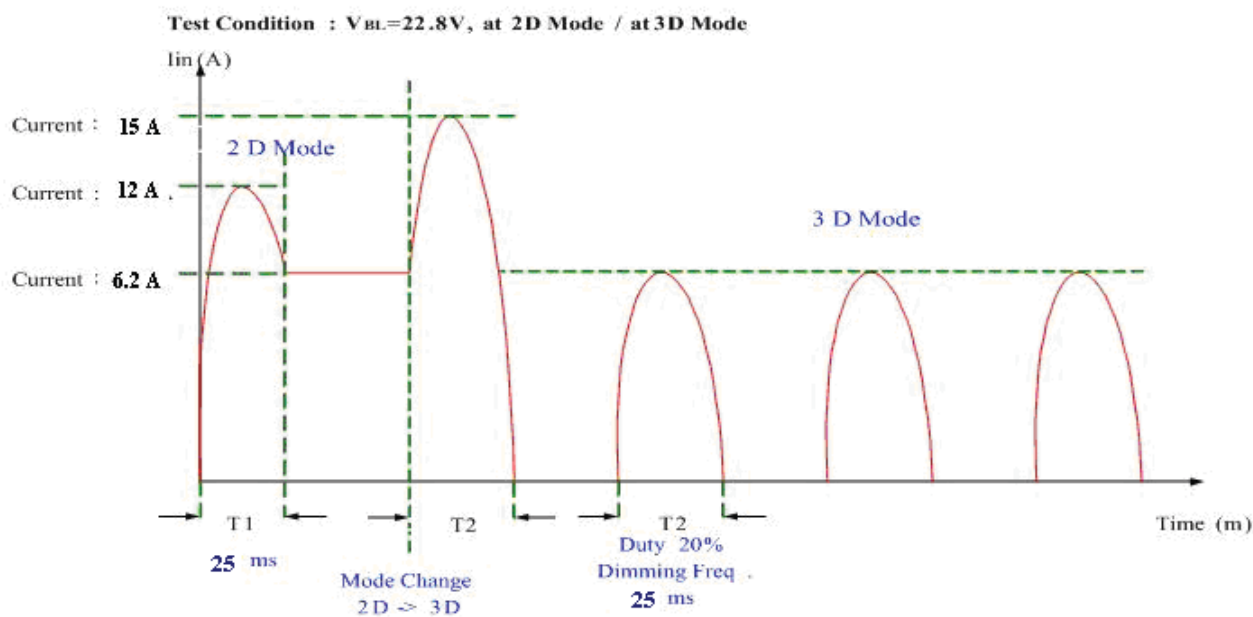
Note (1) The power supply capacity should be higher than the total converter power consumption P_{BL} . Since the pulse width modulation (PWM) mode was applied for backlight dimming, the driving current changed as PWM duty on and off. The transient response of power supply should be considered for the changing loading when converter dimming.

Note (2) The measurement condition of Max. value is based on 58" backlight unit under input voltage 24V, at 2D/3D Mode and lighting 1 hour later.

Note (3) For input inrush current measure, the VBL rising time from 10% to 90% is about 20ms.

Note (4) FB and DDR are available only at 2D Mode.

Note (5) Below diagram is only for power supply design reference.



Note (6) The lifetime is defined as the time which luminance of the LED decays to 50% compared to the initial value,
 Operating condition: Continuous operating at $T_a = 25 \pm 2^\circ C$

3.2.2 CONVERTER INTERFACE CHARACTERISTICS

Parameter	Symbol	Test Condition	Value			Unit	Note		
			Min.	Typ.	Max.				
On/Off Control Voltage	ON	VBLON	—	2.0	—	5.0	V		
	OFF		—	0	—	0.8	V		
External PWM Control Voltage	HI	VEPWM	—	2.0	—	5.25	V	Duty on	(5), (6)
	LO		—	0	—	0.8	V	Duty off	
External PWM Frequency	F _{EPWM}	—	95	160	200	Hz	Normal mode (7)		
Error Signal	ERR	—	—	—	—	—	Abnormal; Open		
VBL Rising Time	Tr1	—	20	—	—	ms	10%-90% V _{BL}		
Control Signal Rising Time	Tr	—	—	—	100	ms			
Control Signal Falling Time	Tf	—	—	—	100	ms			
PWM Signal Rising Time	TPWMR	—	—	—	50	us	(6)		
PWM Signal Falling Time	TPWMF	—	—	—	50	us			
Input Impedance	Rin	—	1	—	—	MΩ	EPWM, BLON		
PWM Delay Time	TPWM	—	100	—	—	ms	(6)		
BLON Delay Time	T _{on}	—	300	—	—	ms			
	T _{on1}	—	300	—	—	ms			
BLON Off Time	Toff	—	300	—	—	ms			

Note (1) The Dimming signal should be valid before backlight turns on by BLON signal. It is inhibited to change the external PWM signal during backlight turn on period.

Note (2) The power sequence and control signal timing are shown in the Fig.1. For a certain reason, the converter has a possibility to be damaged with wrong power sequence and control signal timing.

Note (3) While system is turned ON or OFF, the power sequences must follow as below descriptions:

Turn ON sequence: VBL → PWM signal → BLON

Turn OFF sequence: BLOFF → PWM signal → VBL

Note (4) When converter protective function is triggered, ERR will output open collector status. Please refers to Fig.2.

Note (5) The EPWM interface that inserts a pull up resistor to 5V in Max Duty (100%), please refers to Fig.3.

Note (6) EPWM is available only at 2D Mode.

Note (7) EPWM signal have to input available frequency range.

Note (8) [Recommend] EPWM duty ratio is set at 100%(Max. Brightness) in 3D Mode.

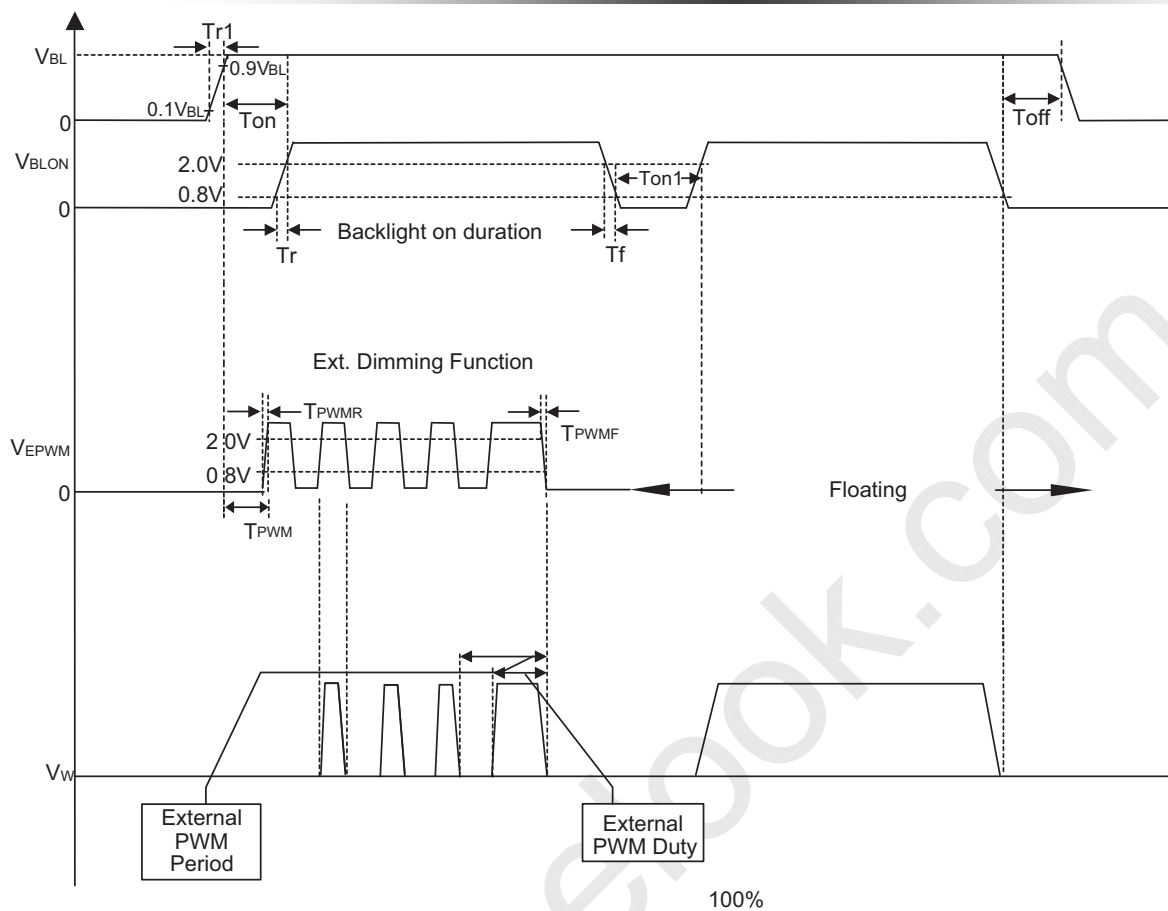


Fig. 1

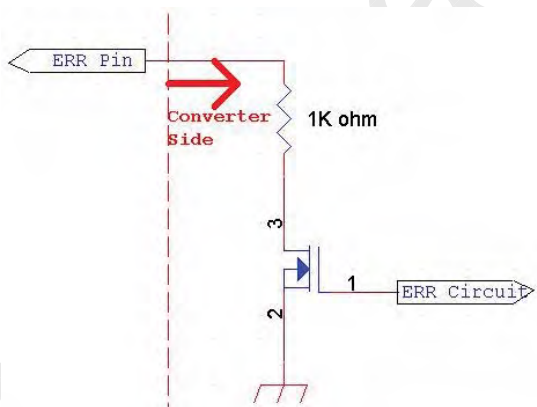


Fig. 2

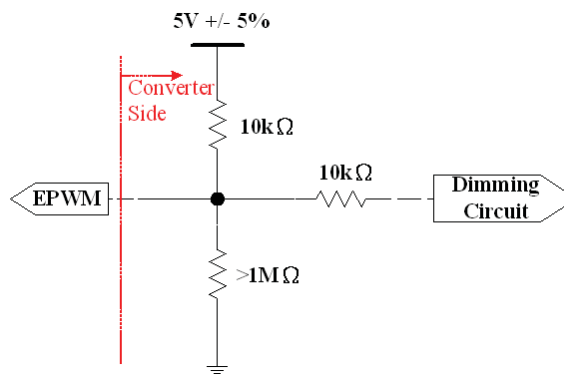
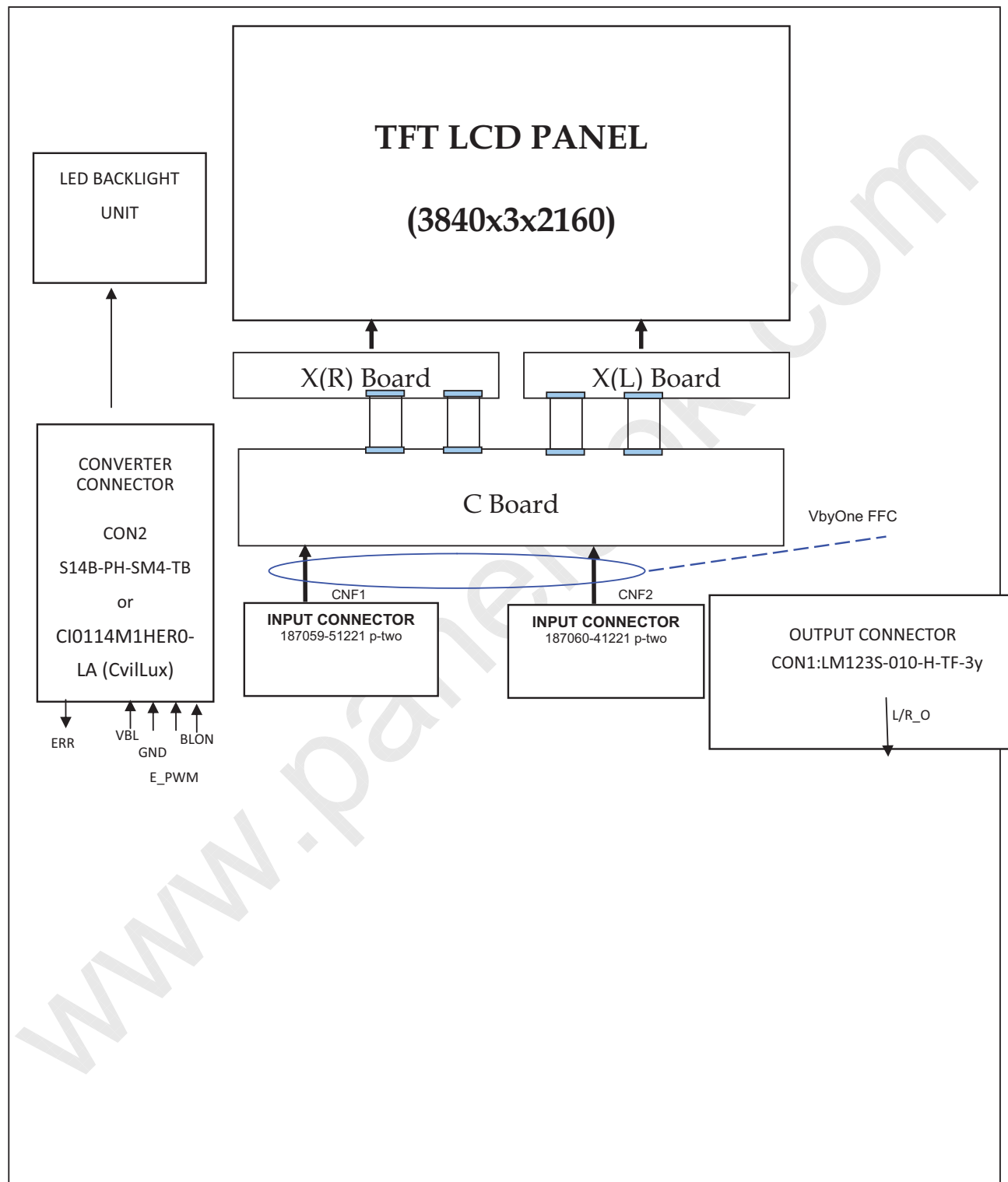


Fig. 3

4. BLOCK DIAGRAM OF INTERFACE

4.1 TFT LCD MODULE



5 .INPUT TERMINAL PIN ASSIGNMENT

5.1 TFT LCD MODULE VbyOne HS INPUT

CNF1 Connector Pin Assignment (P-TWO 187059-51221)

Pin	Name	Description	Note
1	Vin	Power input (+12V)	
2	Vin	Power input (+12V)	
3	Vin	Power input (+12V)	
4	Vin	Power input (+12V)	
5	Vin	Power input (+12V)	
6	Vin	Power input (+12V)	
7	Vin	Power input (+12V)	
8	Vin	Power input (+12V)	
9	Vin	Power input (+12V)	
10	Vin	Power input (+12V)	
11	Vin	Power input (+12V)	
12	Vin	Power input (+12V)	
13	Vin	Power input (+12V)	
14	Vin	Power input (+12V)	
15	N.C.	No Connection	
16	GND	Ground	
17	GND	Ground	
18	GND	Ground	
19	GND	Ground	
20	Rev	CMI internal use, please keep it in open and don't floating.	
21	SCN_EN	Scanning mode enable.	(5) (8)
22	LD_EN	Local Dimming Mode Enable.	(4) (7)
	N.C.	No Connection	(11)
	N.C.	No Connection	
25	HTPDN	Hot plug detect output, Open drain.	
26	LOCKN	Lock detect output, Open drain.	
27	GND	Ground	
28	RX0N	First Pixel Negative VbyOne differential data input in area A. Lan 0.	(1)
29	RX0P	First Pixel Positive VbyOne differential data input in area A. Lan 0.	
30	GND	Ground	
31	RX1N	Second Pixel Negative VbyOne differential data input in area A. Lan 1.	(1)
32	RX1P	Second Pixel Positive VbyOne differential data input in area A. Lan 1.	
33	GND	Ground	
34	RX2N	Third Pixel Negative VbyOne differential data input in area A. Lan 2.	(1)
35	RX2P	Third Pixel Positive VbyOne differential data input in area A. Lan 2.	

36	GND	Ground	
37	RX3N	4.th Pixel Negative VbyOne differential data input in area A. Lan 3.	(1)
38	RX3P	4.th Pixel Positive VbyOne differential data input in area A. Lan 3.	
39	GND	Ground	
40	RX4N	First Pixel Negative VbyOne differential data input in area B. Lan 4.	(1)
41	RX4P	First Pixel Positive VbyOne differential data input in area B. Lan 4.	
42	GND	Ground	
43	RX5N	Second Pixel Negative VbyOne differential data input in area B. Lan 5.	(1)
44	RX5P	Second Pixel Positive VbyOne differential data input in area B. Lan 5.	
45	GND	Ground	
46	RX6N	Third Pixel Negative VbyOne differential data input in area B. Lan 6.	(1)
47	RX6P	Third Pixel Positive VbyOne differential data input in area B. Lan 6.	
48	GND	Ground	
49	RX7N	4.th Pixel Negative VbyOne differential data input in area B. Lan 7.	(1)
50	RX7P	4.th Pixel Positive VbyOne differential data input in area B. Lan 7.	
51	GND	Ground	

CNF2 Connector Pin Assignment (P-TWO 187060-41221)

Pin	Name	Description	Note
1	GND	Ground	
2	RX8N	First Pixel Negative VbyOne differential data input in area C. Lan 8.	(1)
3	RX8P	First Pixel Positive VbyOne differential data input in area C. Lan 8.	
4	GND	Ground	
5	RX9N	Second Pixel Negative VbyOne differential data input in area C. Lan 9.	(1)
6	RX9P	Second Pixel Positive VbyOne differential data input in area C. Lan 9.	
7	GND	Ground	
8	RX10N	Third Pixel Negative VbyOne differential data input in area C. Lan 10.	(1)
9	RX10P	Third Pixel Positive VbyOne differential data input in area C. Lan 10.	
10	GND	Ground	
11	RX11N	4.th Pixel Negative VbyOne differential data input in area C. Lan 11.	(1)
12	RX11P	4.th Pixel Positive VbyOne differential data input in area C. Lan 11.	
13	GND	Ground	
14	RX12N	First Pixel Negative VbyOne differential data input in area D. Lan 12.	(1)
15	RX12P	First Pixel Positive VbyOne differential data input in area D. Lan 12.	
16	GND	Ground	
17	RX13N	Second Pixel Negative VbyOne differential data input in area D. Lan 13.	(1)
18	RX13P	Second Pixel Positive VbyOne differential data input in area D. Lan 13.	

19	GND	Ground	
20	RX14N	Third Pixel Negative VbyOne differential data input in area D. Lan 14.	(1)
21	RX14P	Third Pixel Positive VbyOne differential data input in area D. Lan 14.	
22	GND	Ground	
23	RX15N	4.th Pixel Negative VbyOne differential data input in area D. Lan 15.	(1)
24	RX15P	4.th Pixel Positive VbyOne differential data input in area D. Lan 15.	
25	GND	Ground	
26	N.C.	No Connection	
27	L/R_O	Output signal for Glasses Left Right signal,	(6)
28	L/R	Input signal for Left/Right synchronous signal.	(3) (8)
29	2D/3D	2D/3D Enable	(2) (8)
30	N.C.	No Connection	(11)
31	N.C.	No Connection	
32	N.C.	No Connection	
33	N.C.	No Connection	
34	N.C.	No Connection	
35	N.C.	No Connection	
36	N.C.	No Connection	
37	N.C.	No Connection	
38	N.C.	No Connection	
39	N.C.	No Connection	
40	SCL_TCN_A	I2C for TCON A/B/C/D Device address : C2/C4/C6/C8	(12)
41	SCL_TCN_A	I2C for TCON A/B/C/D Device address : C2/C4/C6/C8	

CON1 Connector Pin Assignment (LM123S-010-H-TF1-3Y (UNE))

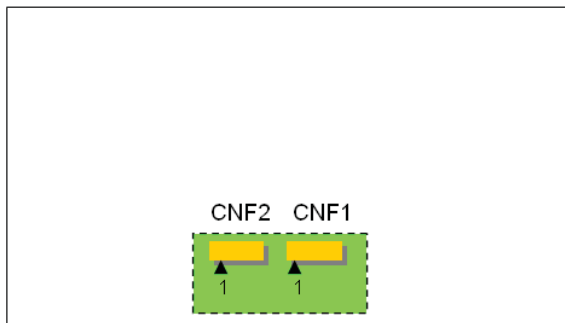
1	N.C.	No Connection	(11)
2	N.C.	No Connection	
3	N.C.	No Connection	
4	GND	Ground	—
5	N.C.	No Connection	(11)
6	L/R_O	Output signal for Left Right Glasses control	(6)
7	N.C.	No Connection	(11)
8	N.C.	No Connection	
9	N.C.	No Connection	
10	N.C.	No Connection	

Note (1) V-by-One® HS Data Mapping

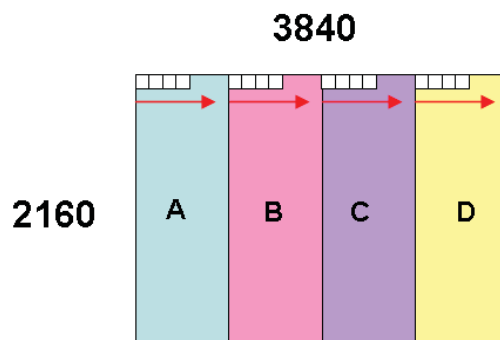
PRODUCT SPECIFICATION

Area	Lan	Data Stream
A	Lan 0	1, 5, 9,, 953, 957
	Lan 1	2, 6, 10,, 954, 958
	Lan 2	3, 7, 11,, 955, 959
	Lan 3	4, 8, 12,, 956, 960
B	Lan 4	961, 965, 969,, 1913, 1917
	Lan 5	962, 966, 970,, 1914, 1918
	Lan 6	963, 967, 971,, 1915, 1919
	Lan 7	964, 968, 972,, 1916, 1920
C	Lan 8	1921, 1925, 1929,, 2873, 2877
	Lan 9	1922, 1926, 1930,, 2874, 2878
	Lan 10	1923, 1927, 1931,, 2875, 2879
	Lan 11	1924, 1928, 1932,, 2876, 2880
D	Lan 12	2881, 2885, 2889,, 3833, 3837
	Lan 13	2882, 2886, 2890,, 3834, 3838
	Lan 14	2883, 2887, 2891,, 3835, 3839
	Lan 15	2884, 2888, 2892,, 3836, 3840

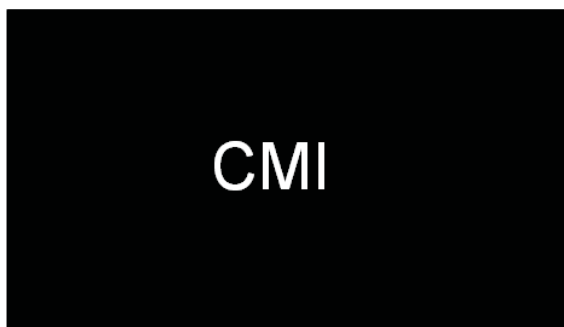
Front View



Pixel arrangement



Display



Data Lane0	A
Data Lane1	
Data Lane2	
Data Lane3	

Data Lane8	C
Data Lane9	
Data Lane10	
Data Lane11	

Data Lane4	B
Data Lane5	
Data Lane6	
Data Lane7	

Data Lane12	D
Data Lane13	
Data Lane14	
Data Lane15	

Note (2) 2D/3D mode selection.

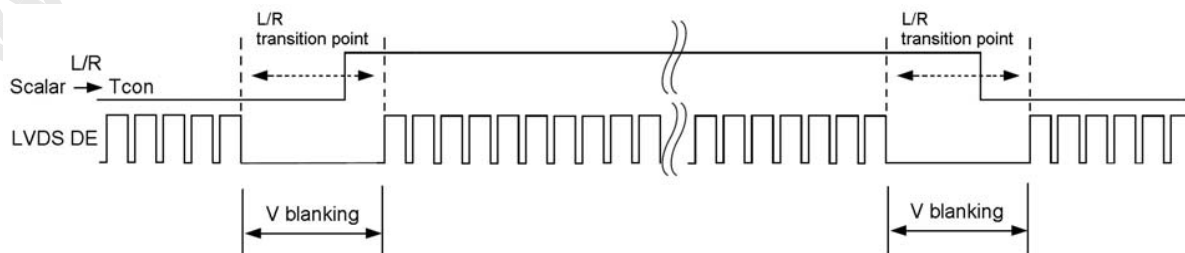
L= Connect to GND or Open, H=Connect to +3.3V

2D/3D	Note
L or Open	2D Mode
H	3D Mode

Note (3) Input signal for Left Right eye frame synchronous

$V_{IL}=0\sim 0.8\text{ V}$, $V_{IH}=2.0\sim 3.3\text{ V}$

L/R	Note
L	Right synchronous signal
H	Left synchronous signal



Note (4) Local dimming enable selection. (Default: enable)

L= Connect to GND, H=Connect to +3.3V or Open

LD_EN	Note
L	Local Dimming Disable
H or Open	Local Dimming Enable

LD_EN enable pin should be set in power on stage.

Backlight should be turned off in the period of changing original setting after power on.

Note (5) Scanning enable selection.

L= Connect to GND or Open, H=Connect to +3.3V

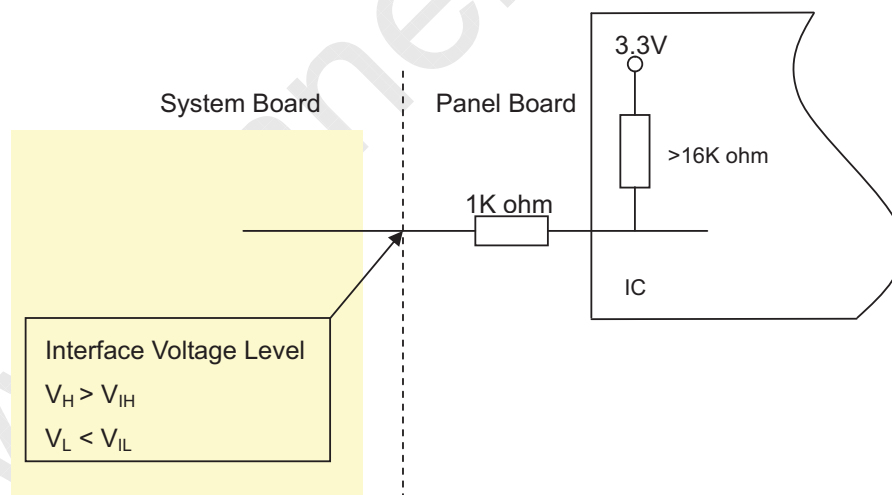
SCN_EN	Note
L or Open	Scanning Disable
H	Scanning Enable

Note (6) The definition of L/R_O signal as follows

L= 0V , H= +3.3V

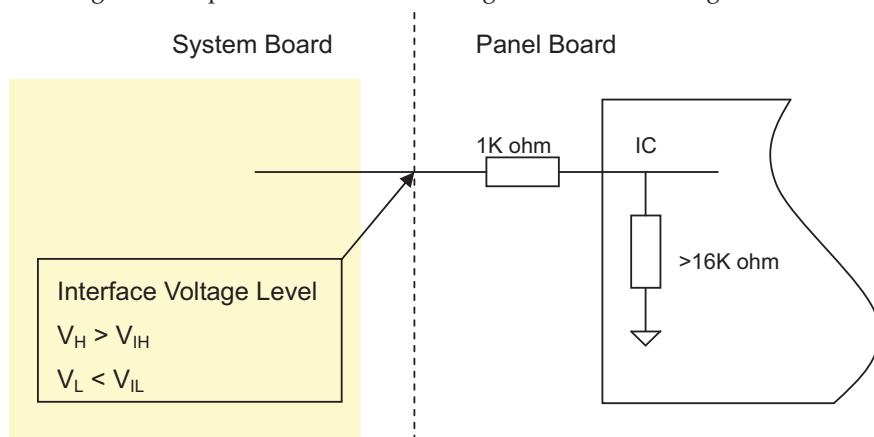
L/R_O	Note
L	Right glass turn on
H	Left glass turn on

Note (7) Interface optional pin has internal scheme as following diagram. Customer should keep the interface voltage level requirement which including Panel board loading as below.

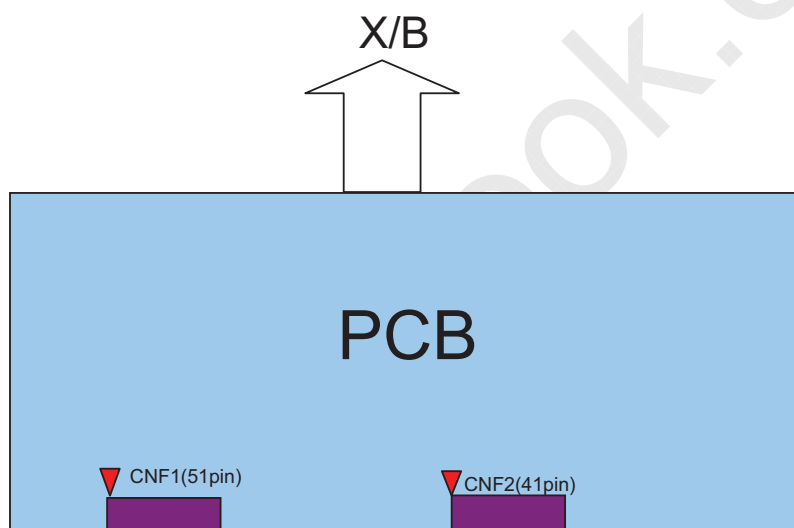


Note (8) Interface optional pin has internal scheme as following diagram. Customer should keep the interface

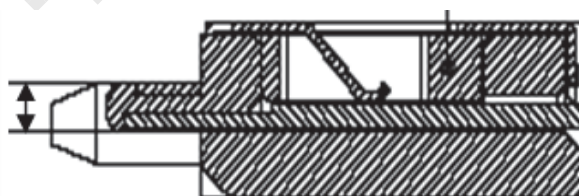
voltage level requirement which including Panel board loading as below.



Note (9) VbyOne HS connector pin order defined as follows



Note (10) LVDS connector mating dimension range request is 0.93mm~1.0mm as below



Note (11) Reserved for internal use. Please leave it open.

Note (12) Local dimming table select for customer use.

5.2 BACKLIGHT UNIT

The pin configuration for the housing and leader wire is shown in the table below.

CN4,5: 196388-12041-3 (P-TWO)

Pin No	Symbol	Feature
1	VLED	Positive of LED String
2	VLED	
3	VLED	
4	NC	NC
5	N1	Negative of LED String
6	N2	
7	N3	
8	N4	
9	N5	
10	N6	
11	N7	
12	N8	

5.3 CONVERTER UNIT

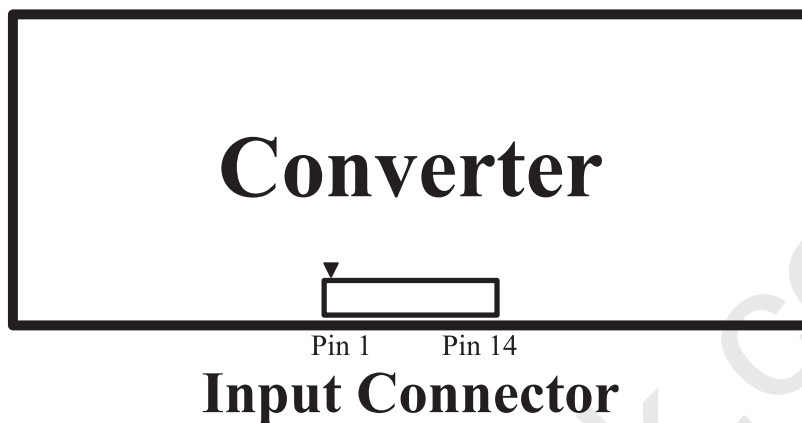
CN1 (Header) : CI0114M1HR0-LA (CvilLux)

Pin No.	Symbol	Feature
1	VBL	+24V
2		
3		
4		
5		
6	GND	GND
7		
8		
9		
10		
11	ERR	Normal (GND) ; Abnormal (Open collector)
12	BLON	BL ON/OFF

13	NC	NC
14	E_PWM	External PWM Control

Note (1) If Pin14 is open, E_PWM is 100% duty.

Note (2) Input connector pin order defined as follows





PRODUCT SPECIFICATION

5.5 COLOR DATA INPUT ASSIGNMENT

The brightness of each primary color (red, green and blue) is based on the 10-bit gray scale data input for the color. The higher the binary input the brighter the color. The table below provides the assignment of color versus data input.

Color		Data Signal																												
		Red										Green										Blue								
		R9	R8	R7	R6	R5	R4	R3	R2	R1	R0	G9	G8	G7	G6	G5	G4	G3	G2	G1	G0	B9	B8	B7	B6	B5	B4	B3	B2	B1
Basic Colors	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1
	Cyan	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Gray Scale Of Red	Red (0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Red (1)	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Red (2)	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Red (1021)	1	1	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Red (1022)	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
Red (1023)	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		
Gray Scale Of Green	Green (0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Green (1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	
	Green (2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	
	Green (1021)	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0	
	Green (1022)	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	
Green (1023)	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0		
Gray Scale Of Blue	Blue (0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Blue (1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	
	Blue (2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	
	Blue (1021)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	
	Blue (1022)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	
Blue (1023)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1		

Note (1) 0: Low Level Voltage , 1: High Level Voltage

6. INTERFACE TIMING

6.1 INPUT SIGNAL TIMING SPECIFICATIONS

Signal	Item	Symbol	Min.	Typ.	Max.	Unit	Note
Frequency	Data Clock	1/Tc	70	74.25	80	MHz	(1)
VbyOne Receiver	Data skew between each area (A/B/C/D)	Tblock			0.06	H	(2)
	Intra-Pair skew		-0.3		0.3	UI	(3)
	Inter-pair skew		-15		15	UI	(4)
	Spread spectrum modulation range	F _{clk_{in} mod}	F _{clk_{in}-0.5%}	—	F _{clk_{in}+0.5%}	MHz	(5)
	Spread spectrum modulation frequency	F _{SSM}	—	—	30	KHz	

6.1.1 Timing spec for Frame Rate = 100Hz

Frame rate	2D mode		Fr5	94	100	106	Hz	(9),(10)
Vertical Active Display Term (4 Lan,960X2160 Active Area)	2D Mode	Total	T _v	2200	2700	2790	Th	T _v =T _{vd} +T _{vb}
		Display	T _{vd}	2160	2160	2160	Th	
		Blank	T _{vb}	40	540	630	Th	
Horizontal Active Display Term (4 Lan,960X2160 Active Area)	2D Mode	Total	T _h	275	285	295	T _c	T _h =T _{hd} +T _{hb}
		Display	T _{hd}	240	240	240	T _c	
		Blank	T _{hb}	35	45	55	T _c	

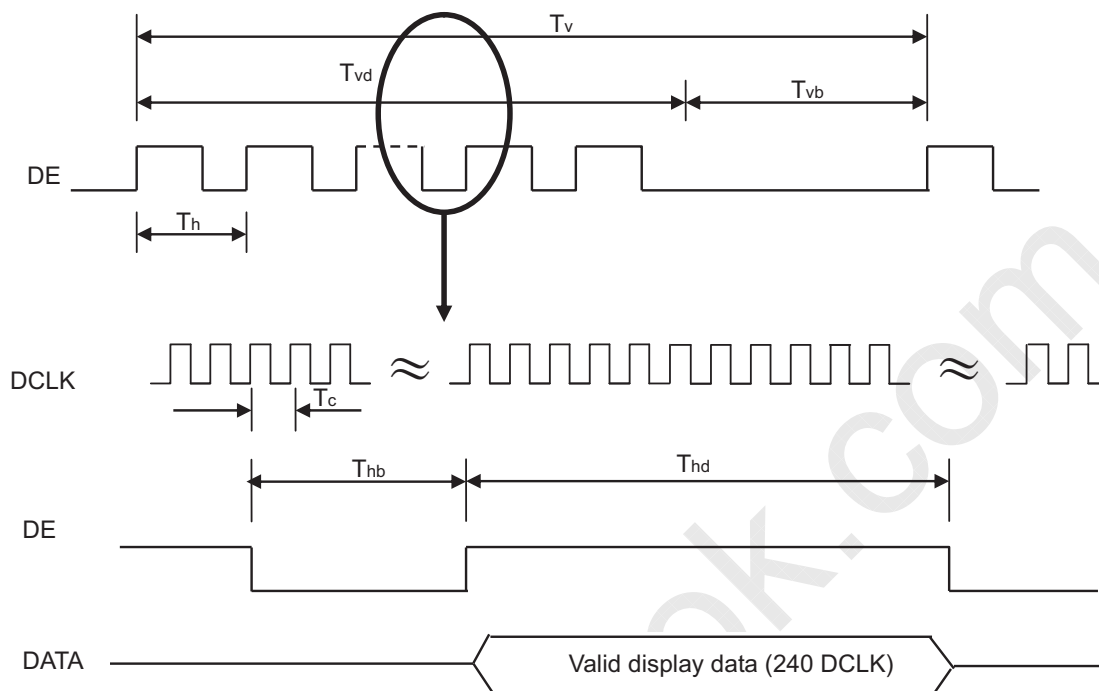
6.1.2 Timing spec for Frame Rate = 120Hz

Frame rate	2D mode		Fr6	114	120	126	Hz	(9),(10)
	3D mode		Fr6	120	120	120	Hz	(7),(9),(10)
Vertical Active Display Term (4 Lan,960X2160 Active Area)	2D Mode	Total	Tv	2200	2250	2790	Th	Tv=Tvd+Tvb
		Display	Tvd	2160	2160	2160	Th	—
		Blank	Tvb	40	90	630	Th	—
	3D Mode	Total	Tv	2250			Th	(6), (8)
		Display	Tvd	2160			Th	
		Blank	Tvb	90			Th	
Horizontal Active Display Term (4 Lan,960X2160 Active Area)	2D Mode	Total	Th	275	285	295	Tc	Th=Thd+Thb
		Display	Thd	240	240	240	Tc	—
		Blank	Thb	35	45	55	Tc	—
	3D Mode	Total	Th	275	285	295	Tc	Th=Thd+Thb
		Display	Thd	240	240	240	Tc	—
		Blank	Thb	35	45	55	Tc	—

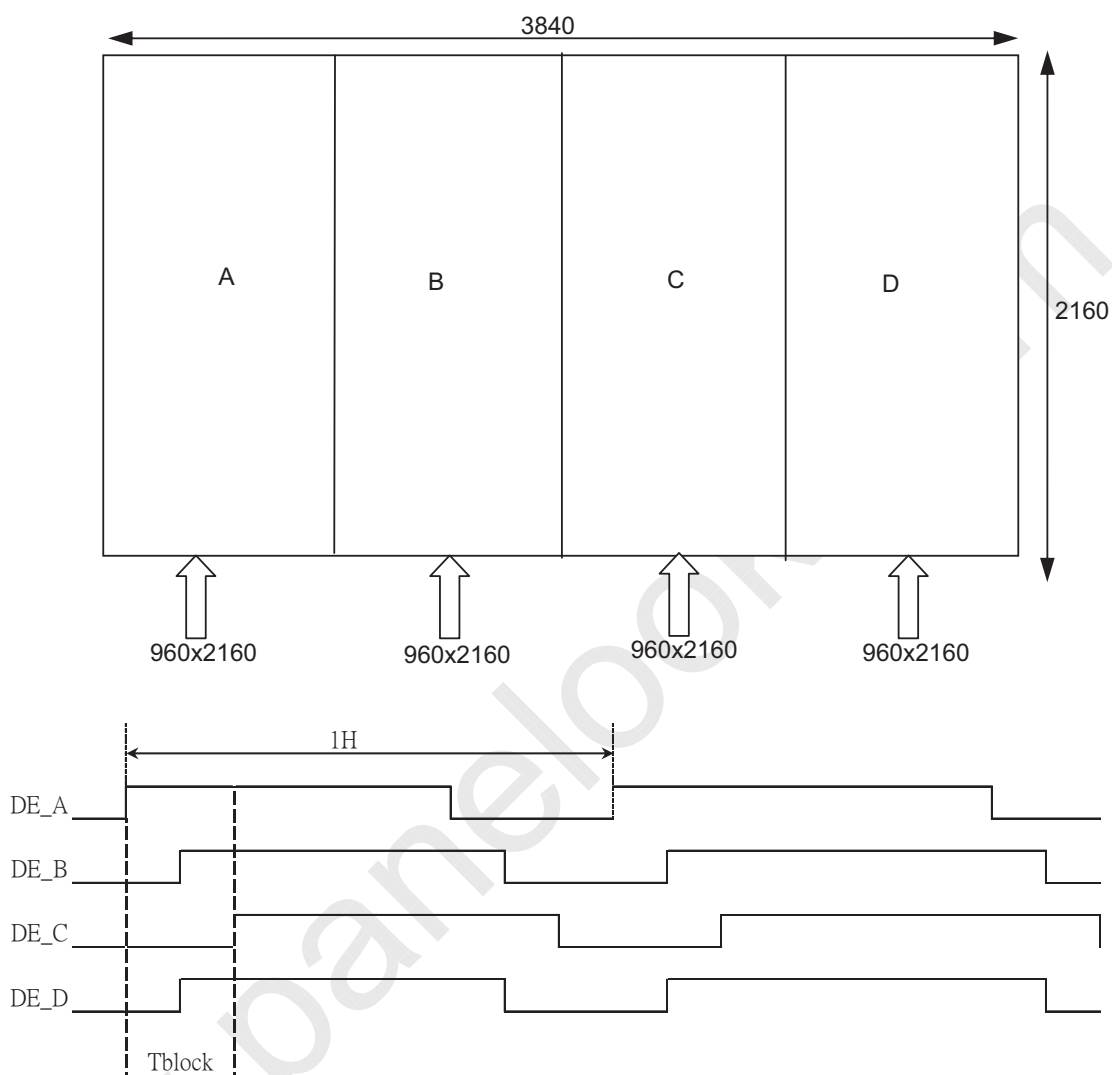
Note (1) Please make sure the range of pixel clock has follow the below equation :

$$Fckin(max) \geq Fr \times Tv \times Th$$

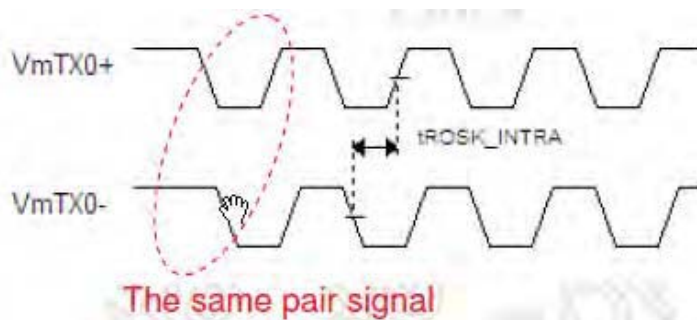
$$Fr \times Tv \times Th \geq Fckin (min)$$

INPUT SIGNAL TIMING DIAGRAM


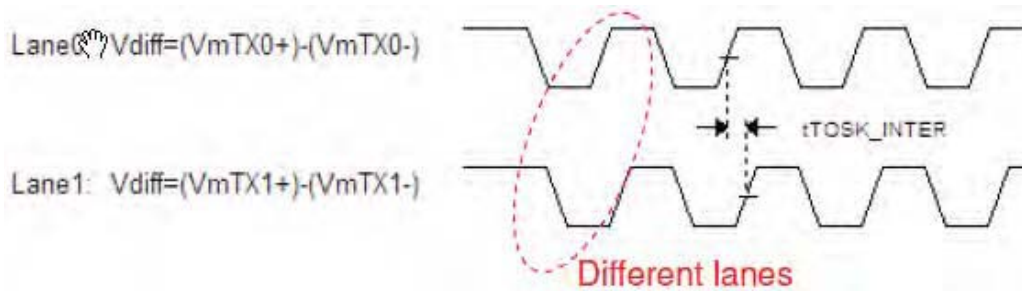
Note (2) Data skew between areas



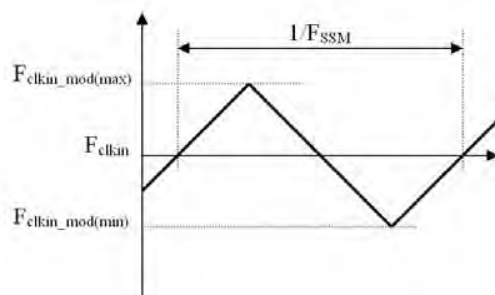
Note (3) VbyOne HS Intra-pair skew



Note (4) VbyOne HS Inter-pair skew.



Note (5) The SSCG (Spread spectrum clock generator) is defined as below figures.



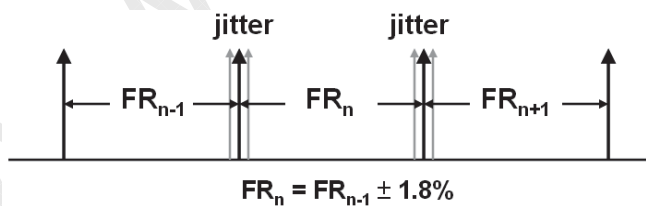
Note (6) Please fix the Vertical timing (Vertical Total =1125 / Display =1080 / Blank = 45) in 120Hz 3D mode

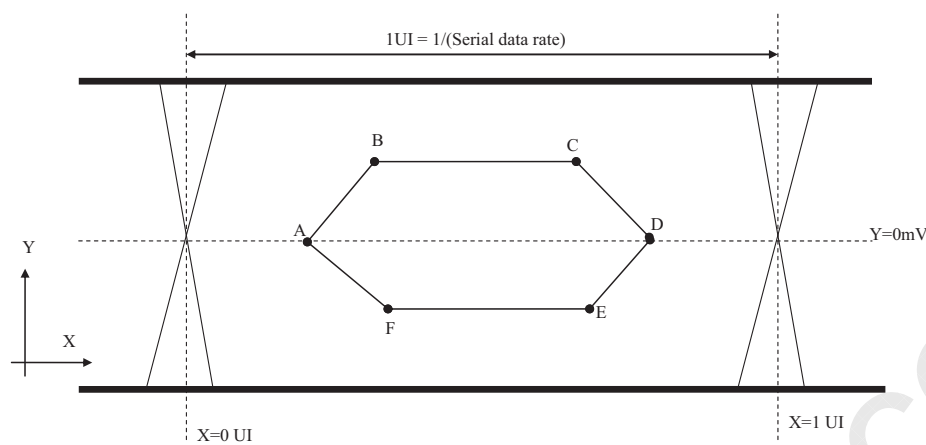
Note (7) In 3D mode, the set up Fr6 in Typ. ± 3 Hz. In order to ensure that the electric function performance to avoid no display symptom.(Except picture quality symptom.)

Note (8) In 3D mode, the set up Tv and Tvb in Typ. ± 30 . In order to ensure that the electric function performance to avoid no display symptom.(Except picture quality symptom.)

Note (9) The frame-to-frame jitter of the input frame rate is defined as the above figures. $FR_n = FR_{n-1} \pm 1.8\%$.

Note (10) The setup of the frame rate jitter > 1.8% may result in the cosmetic LED backlight symptom but the electric function is not affected.



6.2 V by One Input Signal Timing Diagram

Table 1 Eye Mask Specification

	X [UI]	Y [mV]	Note
A	0.25	0	(1)
B	0.3	50	(1)
C	0.7	50	(1)
D	0.75	0	(1)
E	0.7	-50	(1)
F	0.3	-50	(1)

Note (1) Input levels of V-by-One HS signals are comes from "V-by-One HS Stander Ver.1.4"

6.3 Byte Length and Color mapping of V-by-One HS

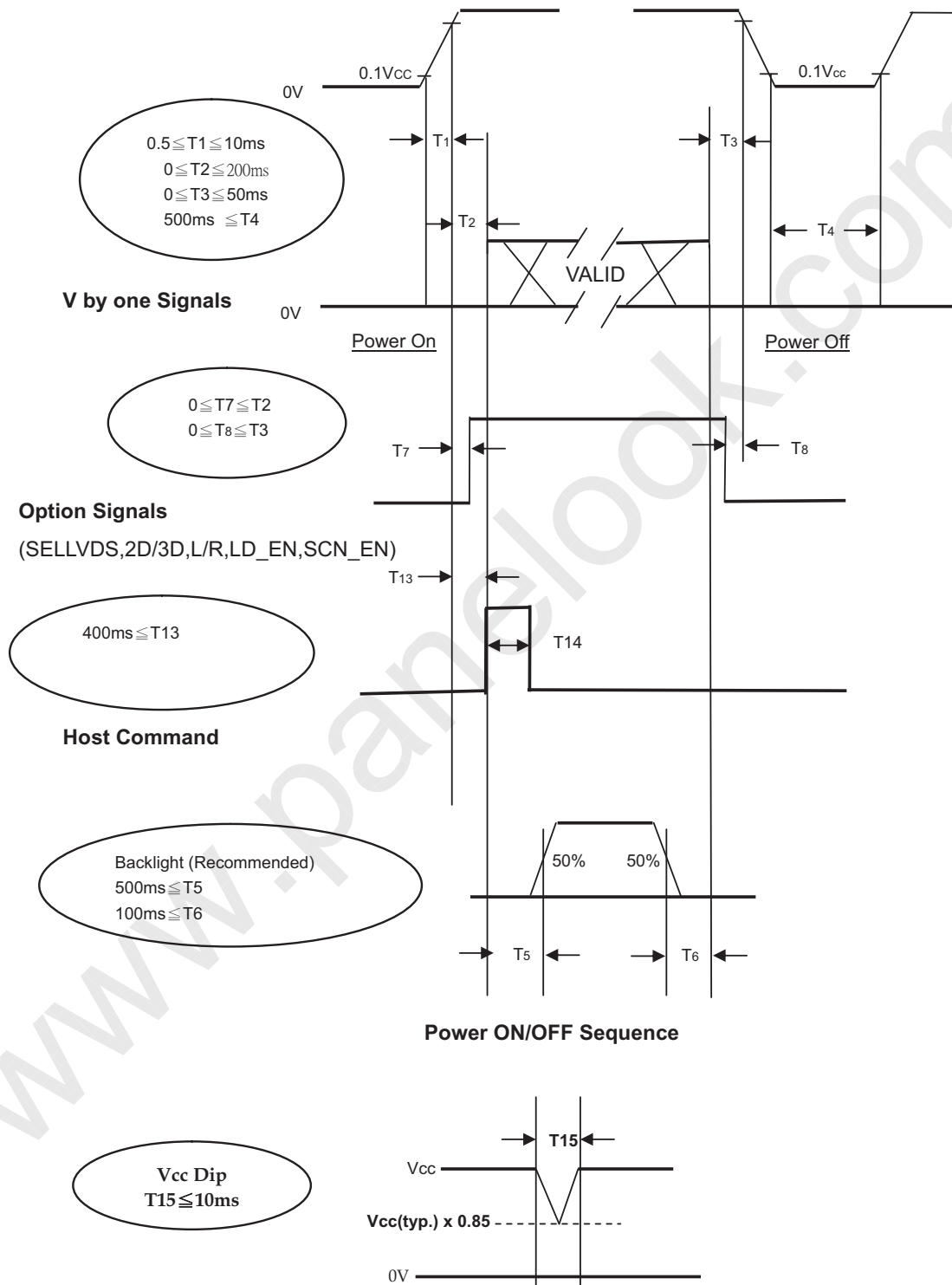
Packer input & Unpacker output		30bpp RGB (10bit)
Byte 0	D[0]	R[2]
	D[1]	R[3]
	D[2]	R[4]
	D[3]	R[5]
	D[4]	R[6]
	D[5]	R[7]
	D[6]	R[8]
Byte 1	D[7]	R[9]
	D[8]	G[2]

	D[9]	G[3]
	D[10]	G[4]
	D[11]	G[5]
	D[12]	G[6]
	D[13]	G[7]
	D[14]	G[8]
	D[15]	G[9]
Byte 2	D[16]	B[2]
	D[17]	B[3]
	D[18]	B[4]
	D[19]	B[5]
	D[20]	B[6]
	D[21]	B[7]
	D[22]	B[8]
Byte 3	D[23]	B[9]
	D[24]	X
	D[25]	X
	D[26]	B[0]
	D[27]	B[1]
	D[28]	G[0]
	D[29]	G[1]
	D[30]	R[0]
D[31]	R[1]	

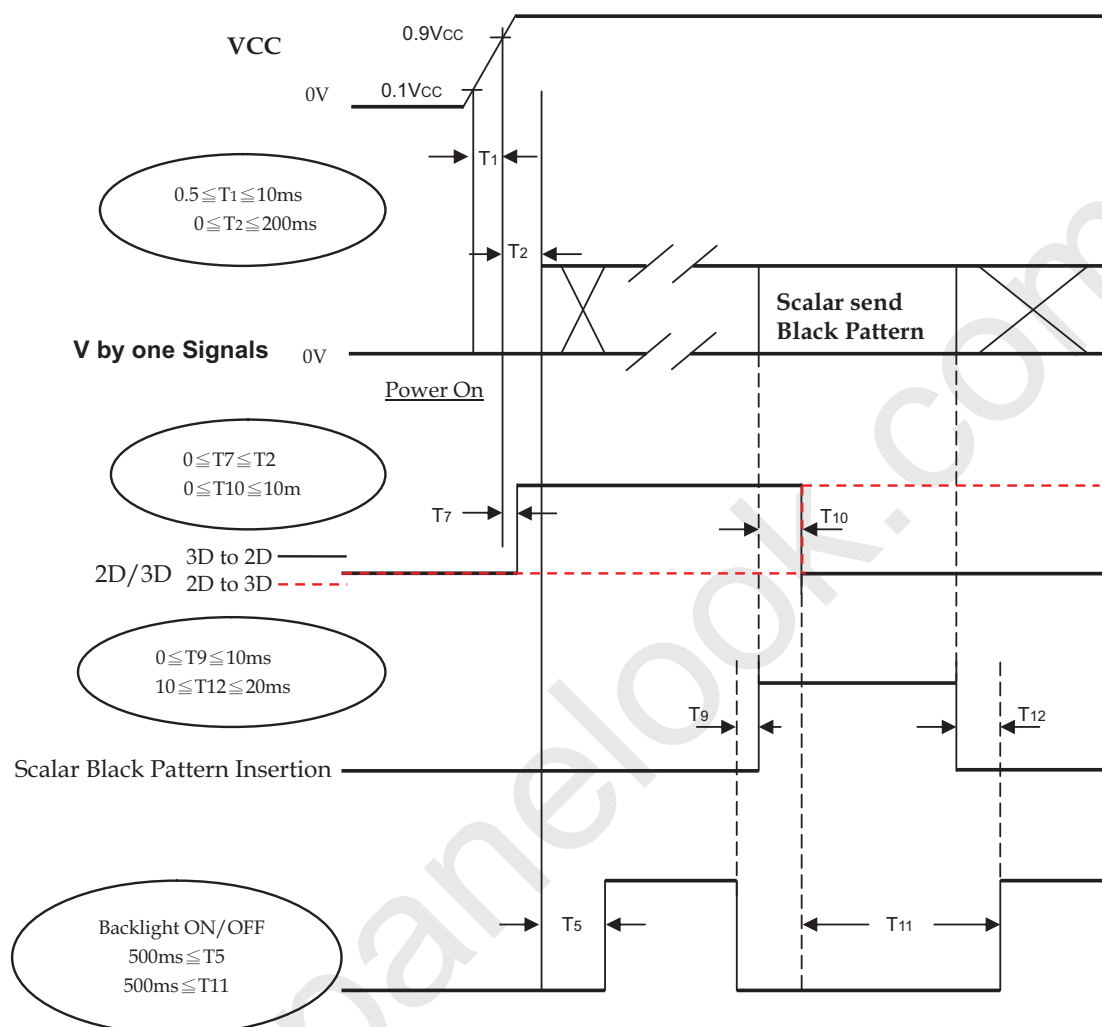
6.4 POWER ON/OFF SEQUENCE

(Ta = 25 ± 2 °C)

To prevent a latch-up or DC operation of LCD module, the power on/off sequence should be as the diagram below.



Power ON/OFF Sequence

6.4 2D/3D MODE CHANGE SIGNAL SEQUENCE WITHOUT VCC TURN OFF AND TURN ON


Note (1) The supply voltage of the external system for the module input should follow the definition of V_{CC}.

Note (2) Apply the LED voltage within the LCD operation range. When the backlight turns on before the LCD operation or the LCD turns off before the backlight turns off, the display may momentarily become abnormal screen.

Note (3) In case of V_{CC} is in off level, please keep the level of input signals on the low or high impedance. If T₂<0, that maybe cause electrical overstress failure.

Note (4) T₄ should be measured after the module has been fully discharged between power off and on period.

Note (5) Interface signal shall not be kept at high impedance when the power is on.

Note (6) When 2D/3D mode is changed, TCON will insert black pattern internally. During black insertion, TCON would load required optical table and TCON parameter setting. The black insertion time should be longer than 650ms because TCON must recognize 2D or 3D format and set the correct parameter.

Note (7) V_{CC} must decay smoothly when power-off.

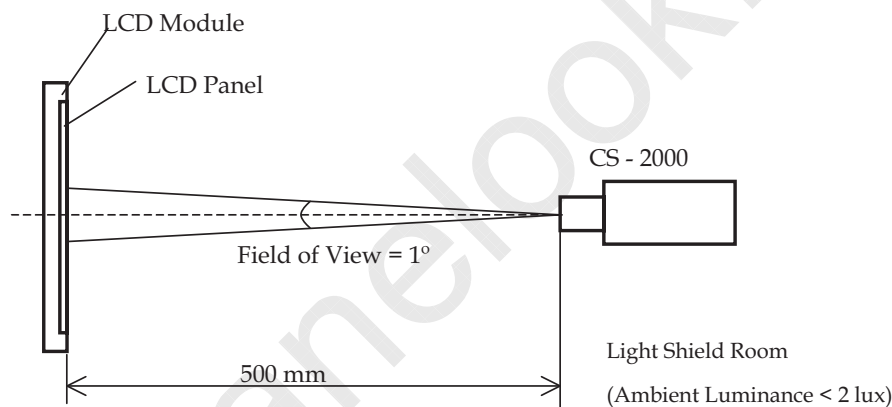
Note (8) T₅ Backlight turn on time depend on T₁₄ command length+T₁₃

7. OPTICAL CHARACTERISTICS
7.1 TEST CONDITIONS

Item	Symbol	Value	Unit
Ambient Temperature	Ta	25±2	°C
Ambient Humidity	Ha	50±10	%RH
Supply Voltage	V _{CC}	12±1.2	V
Input Signal	According to typical value in "3. ELECTRICAL CHARACTERISTICS"		
LED Current	I _L	145±4.35	mA
Vertical Frame Rate	Fr	120	Hz

The LCD module should be stabilized at given temperature for 1 hour to avoid abrupt temperature change during measuring in a windless room.

Local Dimming Function should be Disable before testing to get the steady optical characteristics (According to 5.1 CNF1 Connector Pin Assignment, Pin no. "42")



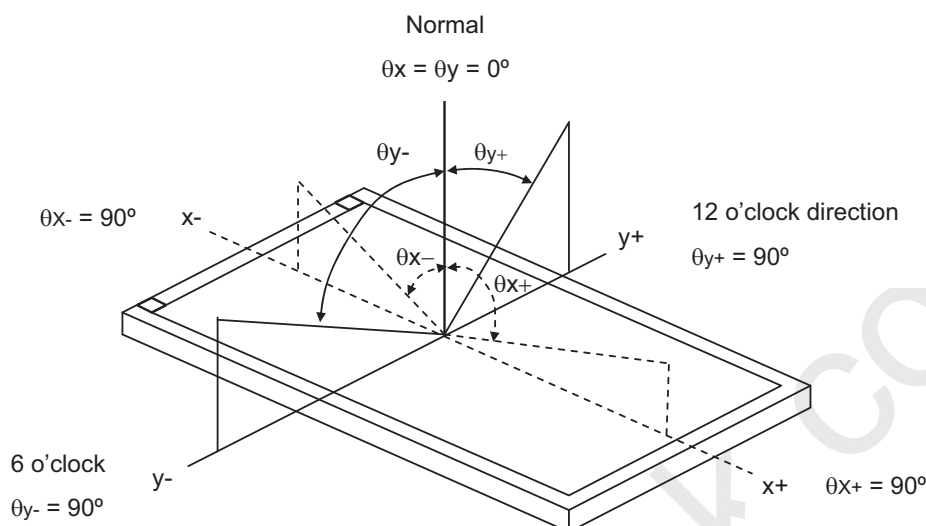
7.2 OPTICAL SPECIFICATIONS

The relative measurement methods of optical characteristics are shown in 7.2. The following items should be measured under the test conditions described in 7.1 and stable environment shown in 7.1.

Item		Symbol	Condition	Min.	Typ.	Max.	Unit	Note
Contrast Ratio		CR	$\theta_x=0^\circ, \theta_y=0^\circ$ Viewing angle at normal direction	3500	5000	-	-	Note (2)
Response Time		Gray to gray			6.5	13	ms	Note (3)
Center Luminance of White	LC	2D		320	400	-	cd/m ²	Note (4)
		3D			TBD	-	cd/m ²	Note (8)
White Variation		δW				1.3	-	Note (6)
Cross Talk	CT	2D		-		4	%	Note (5)
		3D-W			4	-	%	Note (8)
		3D-D			11	-	%	Note (8)
Color Chromaticity	Red	Rx		$\theta_x=0^\circ, \theta_y=0^\circ$ Viewing angle at normal direction	Typ.- 0.03	Typ.+ 0.03	-	
		Ry					-	
	Green	Gx	-					
		Gy	-					
	Blue	Bx	-					
		By	-					
	White	Wx	0.280				-	
		Wy	0.290				-	
Correlated color temperature			9800		K			
Color Gamut	C.G.	-	72	-	%	NTSC		
Viewing Angle	Horizontal	θ_{x+}	CR \geq 20	80	88	-	Deg.	(1)
		θ_{x-}		80	88	-		
	Vertical	θ_{y+}		80	88	-		
		θ_{y-}		80	88	-		
Transmission direction of the up polarizer		Φ_{up}	-	-	90	-	Deg.	(7)

Note (1) Definition of Viewing Angle (θ_x, θ_y) :

Viewing angles are measured by Autronic Conoscope Cono-80(or Eldim EZ-Contrast 160R).



Note (2) Definition of Contrast Ratio (CR) :

The contrast ratio can be calculated by the following expression.

$$\text{Contrast Ratio (CR)} = \frac{\text{Surface Luminance of L1023}}{\text{Surface Luminance of L0}}$$

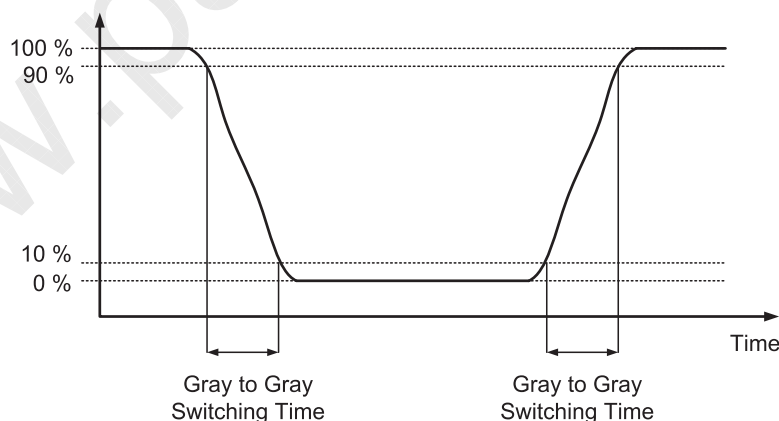
L1023 : Luminance of gray level 1023

L0 : Luminance of gray level 0

CR = CR (X), where CR (X) is corresponding to the Contrast Ratio of the point X at the figure in Note (6).

Note (3) Definition of Gray-to-Gray Switching Time :

Optical Response



The driving signal means the signal of gray level 0, 124, 252, 380, 508, 636, 764, 892 and 1023.

Gray to gray average time means the average switching time of gray level 0, 124, 252, 380, 508, 636, 764, 892 and 1023. to each other.

Note (4) Definition of Luminance of White (L_C) :

Measure the luminance of gray level 1023 at center point.

$L_C = L(5)$, where $L(x)$ is corresponding to the luminance of the point X at the figure in Note (6).

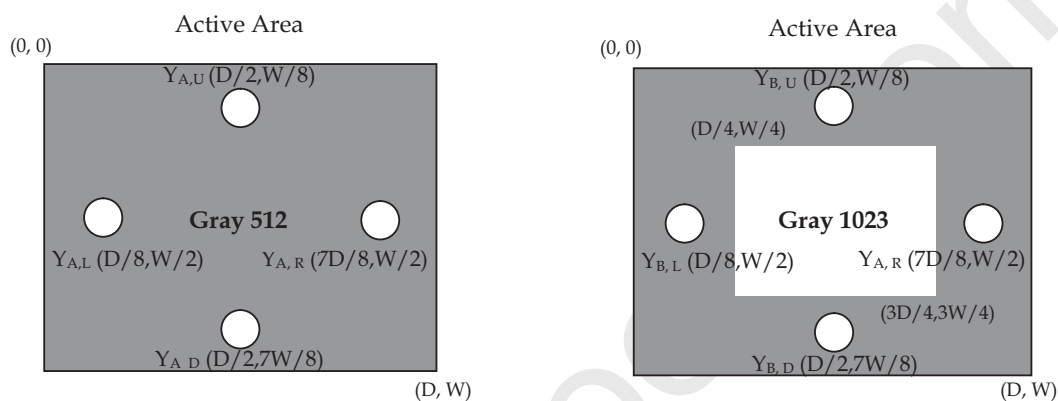
Note (5) Definition of Cross Talk (CT) :

$$CT = | Y_B - Y_A | / Y_A \times 100 (\%)$$

Where :

Y_A = Luminance of measured location without gray level 1023 pattern (cd/m²)

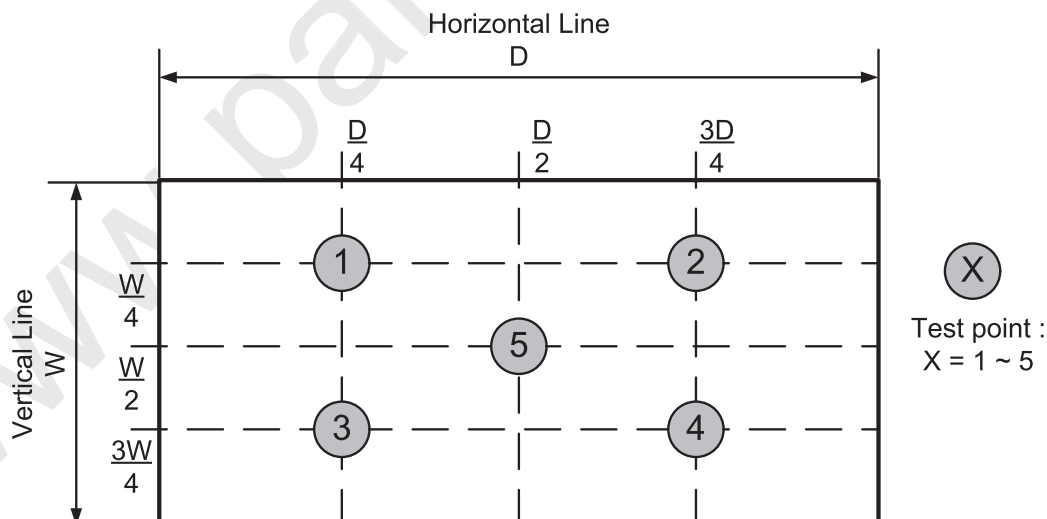
Y_B = Luminance of measured location with gray level 1023 pattern (cd/m²)



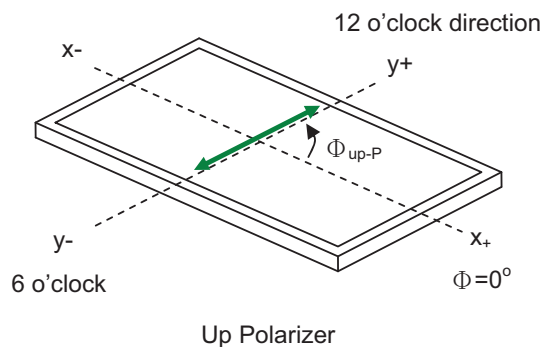
Note (6) Definition of White Variation (δW):

Measure the luminance of gray level 1023 at 5 points

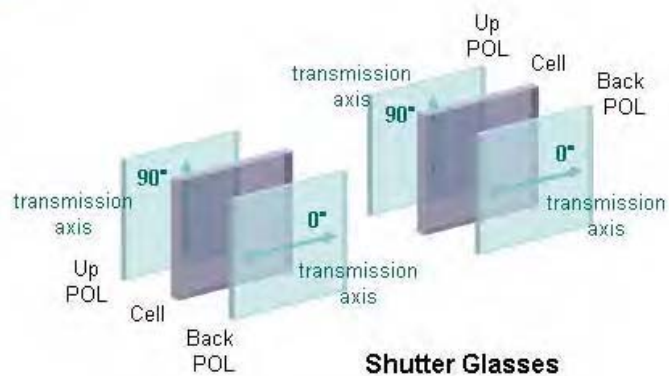
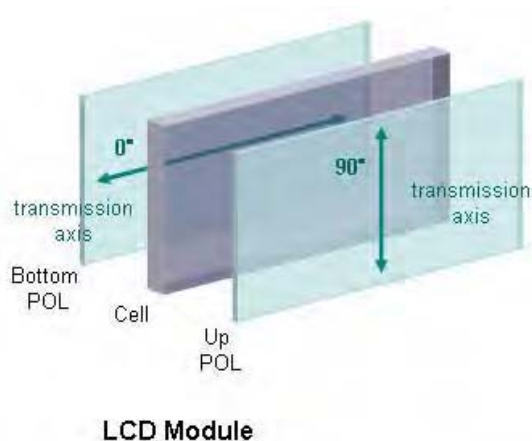
$$\delta W = \frac{\text{Maximum } [L(1), L(2), L(3), L(4), L(5)]}{\text{Minimum } [L(1), L(2), L(3), L(4), L(5)]}$$



Note (7) This is a reference for designing the shutter glasses of 3D application. Definition of the transmission direction of the up polarizer (Φ_{up-p}) on LCD Module :



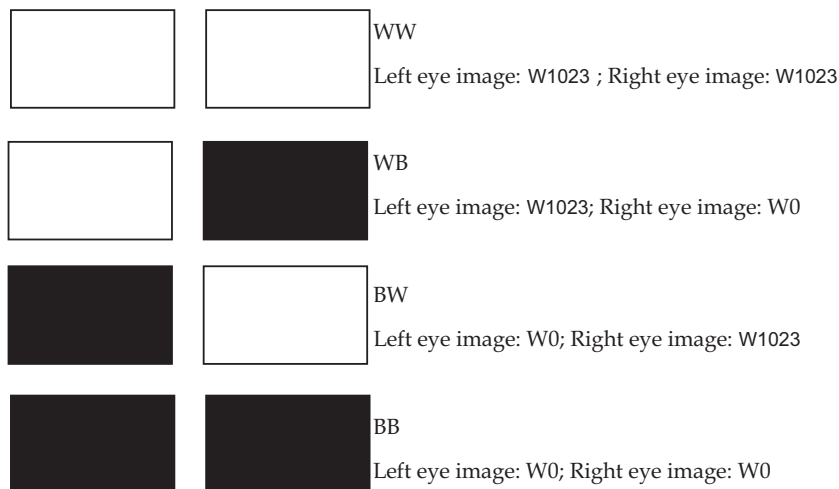
The transmission axis of the front polarizer of the shutter glasses should be parallel to this panel transmission direction to get a maximum 3D mode luminance.



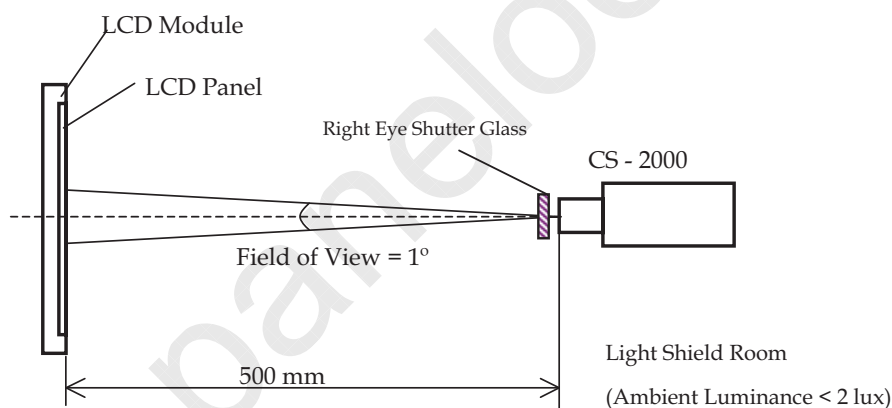
Note (8) Definition of the 3D mode performance (measured under 3D mode, use CMI's shutter glass) :

a. Test pattern

Left eye image and right eye image are displayed alternated



b. Measurement setup



Shutter glasses are well controlled under suitable timing, and measure the luminance of the center point of the panel through the right eye glass. The transmittance of the glass should be larger than 40.0% under 3D mode operation.

The luminance of the test pattern "WW", denoted $L(WW)$; the luminance of the test pattern "WB", denoted $L(WB)$; the luminance of the test pattern "BW", denoted $L(BW)$; the luminance of the test pattern "BB", denoted $L(BB)$

c. Definition of the Center Luminance of White, L_c (3D) : $L(WW)$

d. Definition of the 3D mode white crosstalk, $CT(3D-W)$: $CT(3D-W) \equiv \frac{L(WB) - L(BB)}{L(WW) - L(BB)}$

e. Definition of the 3D mode dark crosstalk, $CT(3D-D)$: $CT(3D-D) \equiv \frac{L(WW) - L(BW)}{L(WW) - L(BB)}$

8. PRECAUTIONS

8.1 ASSEMBLY AND HANDLING PRECAUTIONS

- (1) Do not apply rough force such as bending or twisting to the module during assembly.
- (2) It is recommended to assemble or to install a module into the user's system in clean working areas. The dust and oil may cause electrical short or worsen the polarizer.
- (3) Do not apply pressure or impulse to the module to prevent the damage of LCD panel and backlight.
- (4) Always follow the correct power-on sequence when the LCD module is turned on. This can prevent the damage and latch-up of the CMOS LSI chips.
- (5) Do not plug in or pull out the I/F connector while the module is in operation.
- (6) Do not disassemble the module.
- (7) Use a soft dry cloth without chemicals for cleaning, because the surface of polarizer is very soft and easily scratched.
- (8) Moisture can easily penetrate into LCD module and may cause the damage during operation.
- (9) High temperature or humidity may deteriorate the performance of LCD module. Please store LCD modules in the specified storage conditions.
- (10) When ambient temperature is lower than 10°C, the display quality might be reduced. For example, the response time will become slow, and the starting voltage of LED will be higher than that of room temperature.

8.2 SAFETY PRECAUTIONS

- (1) The startup voltage of a backlight is over 1000 Volts. It may cause an electrical shock while assembling with the inverter. Do not disassemble the module or insert anything into the backlight unit.
- (2) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, skin or clothes, it has to be washed away thoroughly with soap.
- (3) After the module's end of life, it is not harmful in case of normal operation and storage.

8.3 SAFETY STANDARDS

The LCD module should be certified with safety regulations as follows:

Regulatory	Item	Standard
Information Technology equipment	UL	UL60950-1:2006 or Ed.2:2007
	cUL	CAN/CSA C22.2 No.60950-1-03 or 60950-1-07
	CB	IEC60950-1:2005 / EN60950-1:2006+ A11:2009
Audio/Video Apparatus	UL	UL60065 Ed.7:2007
	cUL	CAN/CSA C22.2 No.60065-03:2006 + A1:2006
	CB	IEC60065:2001+ A1:2005 / EN60065:2002 + A1:2006+ A11:2008

If the module displays the same pattern for a long period of time, the phenomenon of image sticking may be occurred.

9. DEFINITION OF LABELS
9.1 CMI MODULE LABEL

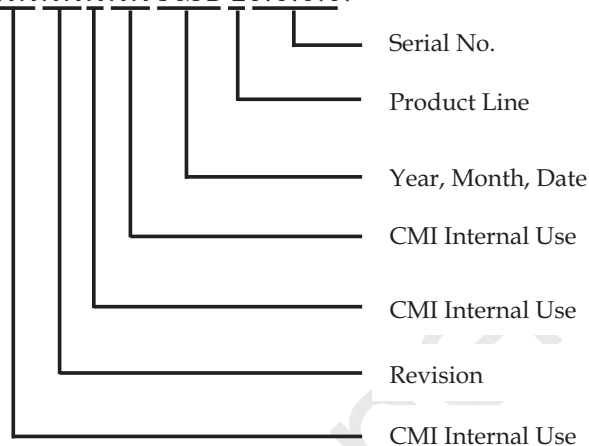
The barcode nameplate is pasted on each module as illustration, and its definitions are as following explanation.



Model Name : V580DK1-KS1

Revision : Rev. XX, for example: A0, A1... B1, B2... or C1, C2...etc.

Serial ID : XXXXXXYMDLNNNN



Serial ID includes the information as below:

Manufactured Date:

Year : 2001=1, 2002=2, 2003=3, 2004=4...2010=0, 2011=1, 2012=2...

Month: 1~9, A~C, for Jan. ~ Dec.

Day: 1~9, A~Y, for 1st to 31st, exclude I ,O, and U.

Revision Code : Cover all the change

Serial No. : Manufacturing sequence of product

Product Line : 1 → Line1, 2 → Line 2, ...etc.

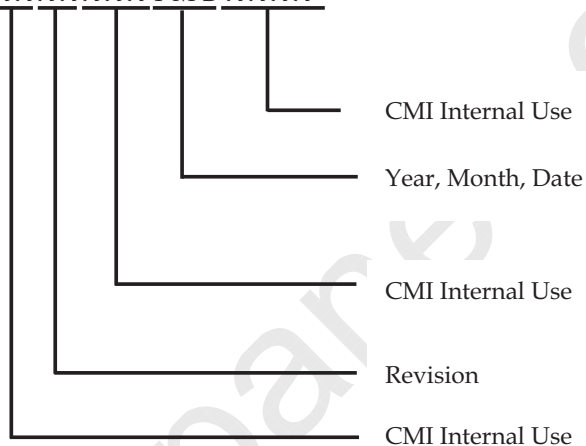
9.2 CARTON LABEL

The barcode nameplate is pasted on each box as illustration, and its definitions are as following explanation.

P.O. NO.	_____
Parts ID.	_____
Model Name	V580DK1-KS1
Carton ID.	XXXXXXXXXXXXXXXX
Quantities	___
Made In Taiwan (Made In China)	

Model Name: V580DK1- KS1

Carton ID: X X X X X X Y M D X X X X



Serial ID includes the information as below :

Manufactured Date:

Year: 2010=0, 2011=1, 2012=2...etc.

Month: 1~9, A~C, for Jan. ~ Dec.

Day: 1~9, A~Y, for 1st to 31st, exclude I ,O, and U.

Revision Code: Cover all the change

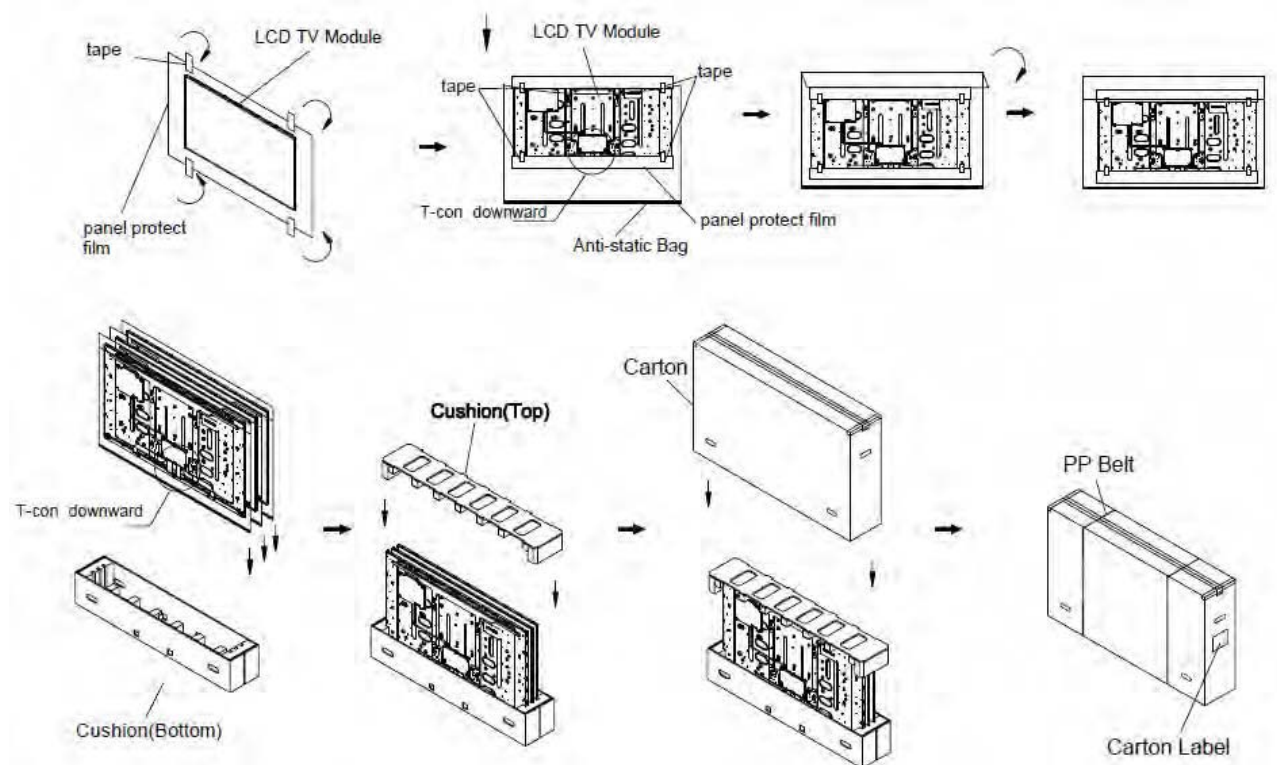
10. PACKAGING

10.1 PACKAGING SPECIFICATIONS

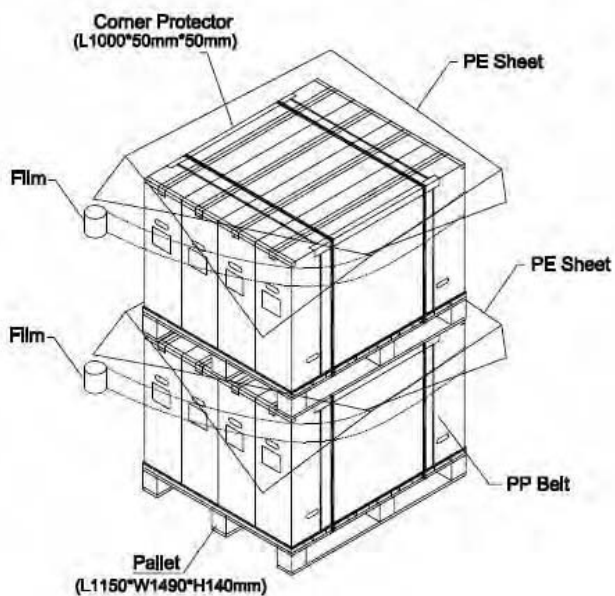
- (1) 3 LCD TV modules / 1 Box
- (2) Box dimensions: 1448(L) X 283 (W) X 846 (H)
- (3) Weight: approximately 59 Kg (3 modules per box)

10.2 PACKAGING METHOD

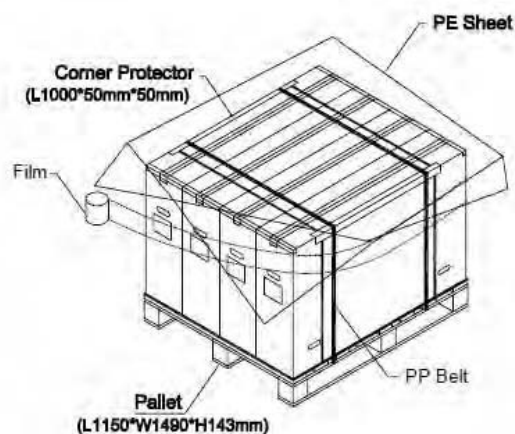
Packaging method is shown in following figures.



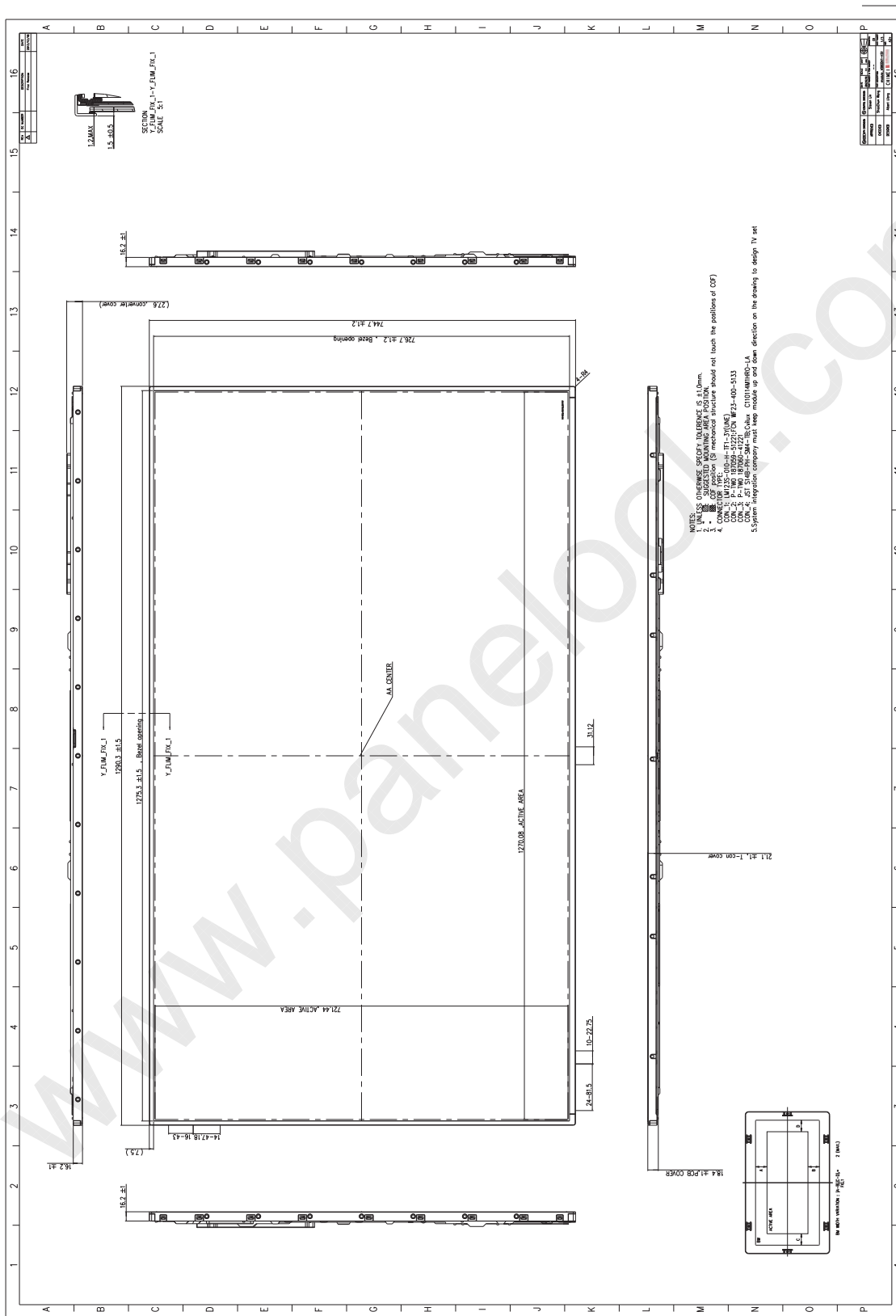
Sea / Land Transportation (40ft & 40ft HQ Container)

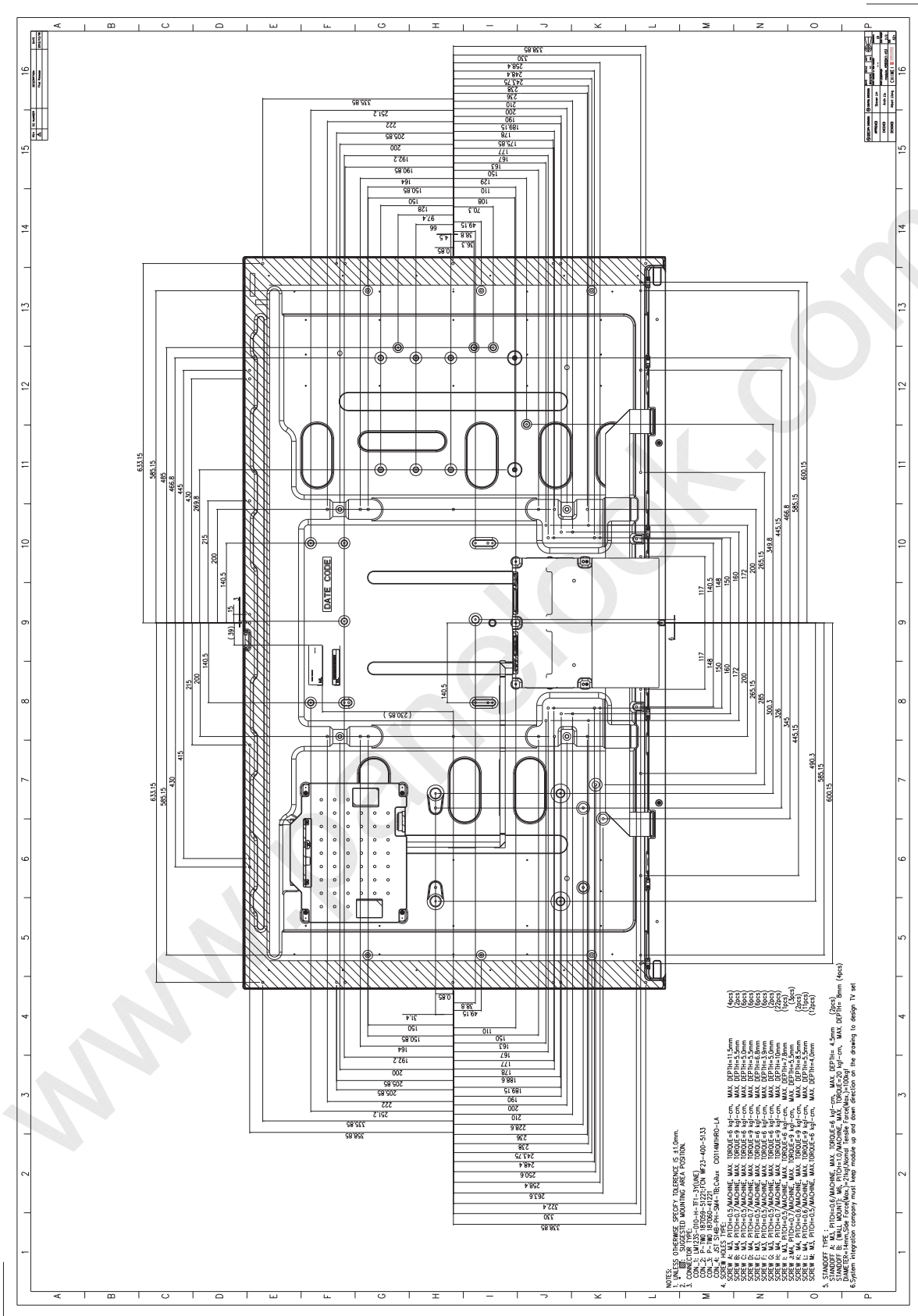


Air Transportation

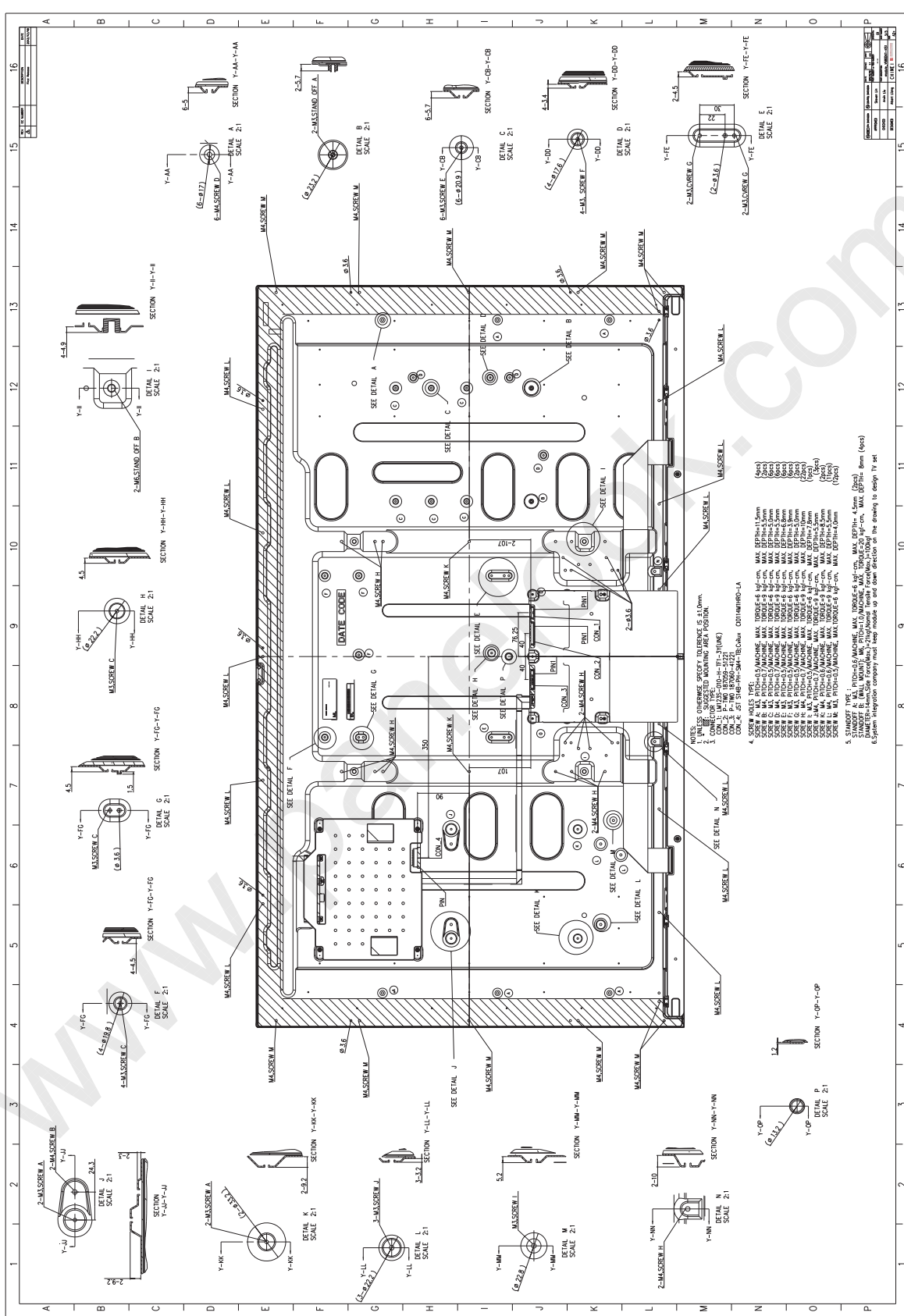


11. MECHANICAL CHARACTERISTIC





- NOTES:
1. UNLESS OTHERWISE SPECIFY TOLERANCE IS ±0.0mm.
 2. CONNECTION TYPE: 4. Mounting Angle Position.
 3. CONNECTION TYPE: 4. Mounting Angle Position.
 4. CON. 2, P. 181, 19709-5122 (CN) W23-400-5133
CON. 2, P. 181, 19709-5122 (CN) W23-400-5133
CON. 2, P. 181, 19709-5122 (CN) W23-400-5133
CON. 2, P. 181, 19709-5122 (CN) W23-400-5133
 5. STANDOFF TYPE: 1. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
2. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
3. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
4. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
5. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
6. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
7. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
8. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
9. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
10. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
11. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
12. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
13. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
14. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
15. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
16. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
17. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
18. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
19. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
20. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
21. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
22. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
23. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
24. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
25. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
26. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
27. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
28. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
29. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
30. PITCH=0.5mm, MAX. TORQUE=1.4g-cm, MAX. DEPTH=1.5mm
 6. System temperature company must keep inside up and down direction of the drawing to design TV set



Appendix A
Local Dimming demo function
A.1 I2C address and write command

Device address: 0xC2

Register address: 0x01

Command data: 0x00: Local Dimming demo mode OFF (Note 1)

0x01: Local Dimming demo mode ON (Demo in right half screen) (Note 2)

	Device Address		Register Address		Command Data		
START	11000010 (0xC2)	ACK	00000001 (0x01)	ACK	00000001 (0x01)	ACK	STOP

Note 1: Local Dimming demo OFF



Note 2: Local Dimming demo ON



A.2 I2C timing

Symbol	Parameter	Min.	Max.	Unit
t_{SU-STA}	Start setup time	250	-	ns
t_{HD-STA}	Start hold time	250	-	ns
t_{SU-DAT}	Data setup time	80	-	ns
t_{HD-DAT}	Data hold time	0	-	ns
t_{SU-STO}	Stop setup time	250	-	ns
t_{BUF}	Time between Stop condition and next Start condition	500	-	ns

